

SLOS600A - DECEMBER 2009-REVISED AUGUST 2010

TAS5711

# 20-W DIGITAL AUDIO-POWER AMPLIFIER WITH EQ, DRC, AND 2.1 MODE

Check for Samples: TAS5711

# FEATURES

- **Audio Input/Output** 
  - 20-W Into an 8- $\Omega$  Load From an 18-V Supply
  - Wide PVDD Range, From 8 V to 26 V
  - Efficient Class-D Operation Eliminates **Need for Heatsinks**
  - One Serial Audio Input (Two Audio Channels)
  - 2.1 Mode (2 SE + 1 BTL)
  - 2.0 Mode (2 BTL)
  - Single-Filter PBTL Mode Support
  - I<sup>2</sup>C Address Selection Pin (Chip Select)
  - Supports 8-kHz to 48-kHz Sample Rate  $(LJ/RJ/I^2S)$
- Audio/PWM Processing
  - Independent Channel Volume Controls With 24-dB to Mute
  - Separate Dynamic Range Control for Satellite and Subchannels
  - 21 Programmable Biguads for Speaker EQ and Other Audio Processing Features
  - Programmable Coefficients for DRC Filters
  - DC Blocking Filters
  - Support for 3D Effects
- **General Features** 
  - Serial Control Interface Operational Without MCLK
  - Factory-Trimmed Internal Oscillator for **Automatic Rate Detection**
  - Surface Mount, 48-Pin, 7-mm × 7-mm **HTQFP** Package
  - Thermal and Short-Circuit Protection
  - Support for AD or BD Mode

- **Benefits** 
  - Up to 90% Efficient
  - AD and BD Filter Mode Support
  - SNR: 106 dB, A-Weighted
  - EQ: Speaker Equalization Improves Audio Performance
  - DRC: Dynamic Range Compression. Can Be Used As Power Limiter. Enables Speaker Protection, Easy Listening, Night-Mode Listening.
  - Separate DRC for Satellite and Subchannels
  - **Autobank Switching: Preload Coefficients** for Different Sample Rates. No Need to Write new Coefficients to the Part When Sample Rate Changes.
  - **Autodetect: Automatically Detects** Sample-Rate Changes. No Need for **External Microprocessor Intervention**
- **Requires Only 3.3 V and PVDD**

## APPLICATIONS

- Television
- iPod<sup>™</sup> Dock
- Sound Bar

## DESCRIPTION

The TAS5711 is a 20-W, efficient, digital audio power amplifier for driving stereo bridge-tied speakers. One serial data input allows processing of up to two discrete audio channels and seamless integration to most digital audio processors and MPEG decoders. The device accepts a wide range of input data and data rates. A fully programmable data path routes these channels to the internal speaker drivers.

The TAS5711 is an I<sup>2</sup>S slave-only device receiving all clocks from external sources. The TAS5711 operates with a PWM carrier between 384-kHz switching rate and 352-KHz switching rate depending on the input sample rate. Oversampling combined with а fourth-order noise shaper provides a flat noise floor and excellent dynamic range from 20 Hz to 20 kHz.

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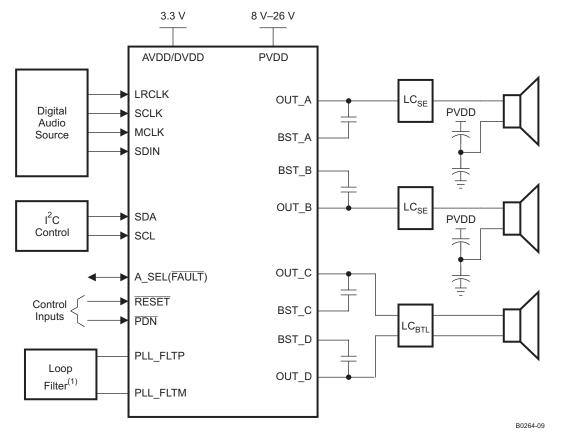
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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# SIMPLIFIED APPLICATION DIAGRAM



(1) See TAS5711 EVM User's Guide (SLOU280) for loop filter values.

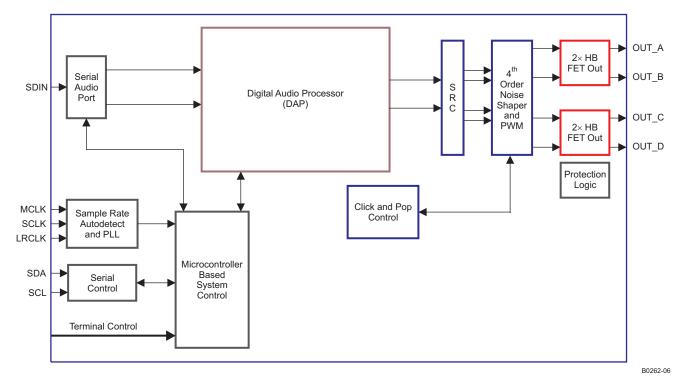


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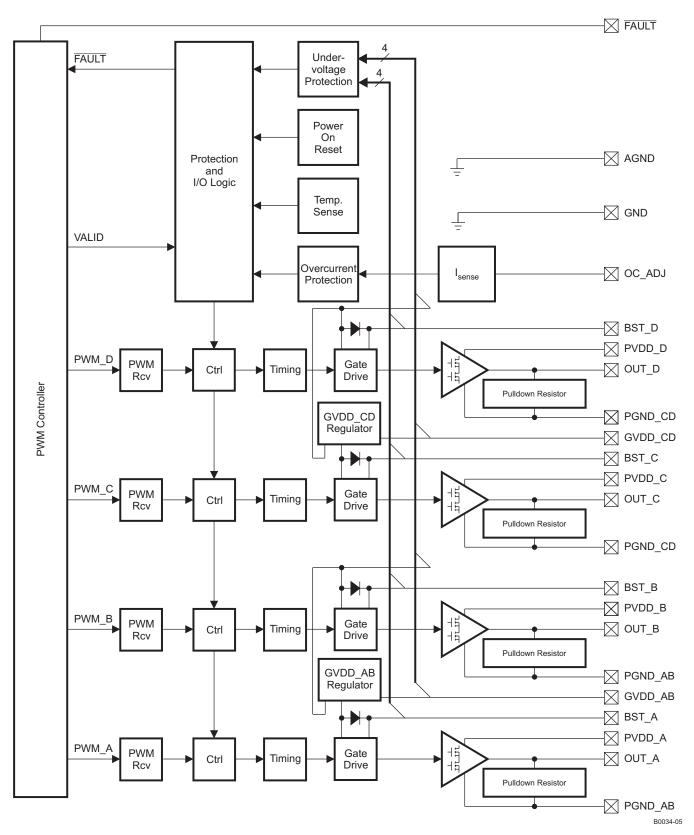
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#### **FUNCTIONAL VIEW**





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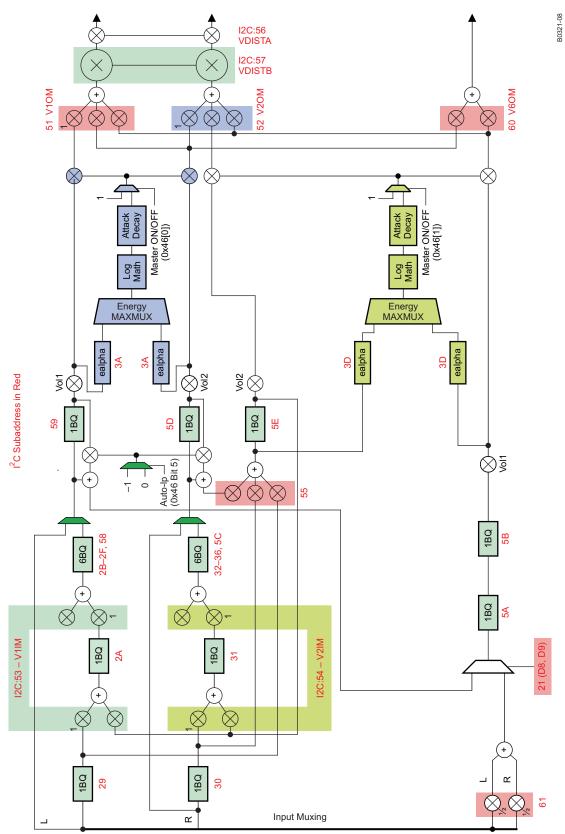






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### DAP Process Structure

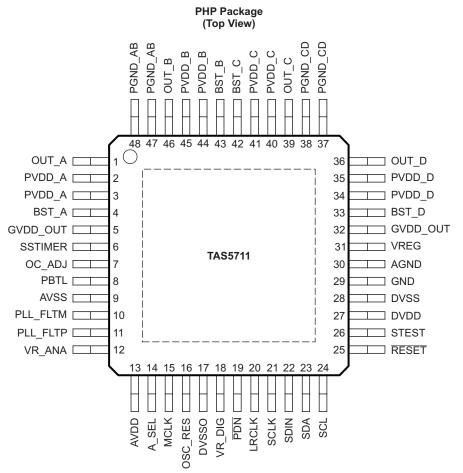


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#### **DEVICE INFORMATION**

#### **PIN ASSIGNMENT**



P0075-08

#### **PIN FUNCTIONS**

PIN		TYPE <sup>(1)</sup>	5-V	TERMINATION <sup>(2)</sup>	DESCRIPTION
NAME	NO.	ITPE	TOLERANT	TERMINATION -/	DESCRIPTION
AGND	30	Р			Analog ground for power stage
A_SEL	14	DIO			A value of 0 (15-k $\Omega$ pulldown) makes the I <sup>2</sup> C device address 0x34, and a value of 1 (15-k $\Omega$ pullup) makes it 0x36. This pin can be programmed after RESET to be an output by writing 1 to bit 0 of I <sup>2</sup> C register 0x05. In that mode, the A_SEL pin is redefined as FAULT (see ERROR REPORTING for details).
AVDD	13	Р			3.3-V analog power supply
AVSS	9	Р			Analog 3.3-V supply ground
BST_A	4	Р			High-side bootstrap supply for half-bridge A
BST_B	43	Р			High-side bootstrap supply for half-bridge B
BST_C	42	Р			High-side bootstrap supply for half-bridge C
BST_D	33	Р			High-side bootstrap supply for half-bridge D
DVDD	27	Р			3.3-V digital power supply
DVSSO	17	Р			Oscillator ground

(1) TYPE: A = analog; D = 3.3-V digital; P = power/ground/decoupling; I = input; O = output

(2) All pullups are weak pullups and all pulldowns are weak pulldowns. The pullups and pulldowns are included to assure proper input logic levels if the pins are left unconnected (pullups → logic 1 input; pulldowns → logic 0 input).



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# **PIN FUNCTIONS (continued)**

PIN			5-V	(2)	
NAME	NO.	TYPE <sup>(1)</sup>	TOLERANT	TERMINATION <sup>(2)</sup>	DESCRIPTION
DVSS	28	Р			Digital ground
GND	29	Р			Analog ground for power stage
GVDD_OUT	5, 32	Р			Gate drive internal regulator output. This pin must not be used to drive external devices.
LRCLK	20	DI	5-V	Pulldown	Input serial audio data left/right clock (sample rate clock)
MCLK	15	DI	5-V	Pulldown	Master clock input
OC_ADJ	7	AO			Analog overcurrent programming. Requires resistor to ground.
OSC_RES	16	AO			Oscillator trim resistor. Connect an 18.2-k $\Omega$ 1% resistor to DVSSO.
OUT_A	1	0			Output, half-bridge A
OUT_B	46	0			Output, half-bridge B
OUT_C	39	0			Output, half-bridge C
OUT_D	36	0			Output, half-bridge D
PBTL	8	DI			Low means BTL or SE mode; high means PBTL mode. Information goes directly to power stage.
PDN	19	DI	5-V	Pullup	Power down, active-low. PDN prepares the device for loss of power supplies by shutting down the Noise Shaper and initiating PWM stop sequence.
PGND_AB	47, 48	Р			Power ground for half-bridges A and B
PGND_CD	37, 38	Р			Power ground for half-bridges C and D
PLL_FLTM	10	AO			PLL negative loop filter terminal
PLL_FLTP	11	AO			PLL positive loop filter terminal
PVDD_A	2, 3	Р			Power supply input for half-bridge output A
PVDD_B	44, 45	Р			Power supply input for half-bridge output B
PVDD_C	40, 41	Р			Power supply input for half-bridge output C
PVDD_D	34, 35	Р			Power supply input for half-bridge output D
RESET	25	DI	5-V	Pullup	Reset, active-low. A system reset is generated by applying a logic low to this pin. RESET is an asynchronous control signal that restores the DAP to its default conditions, and places the PWM in the hard mute state (tristated).
SCL	24	DI	5-V		I <sup>2</sup> C serial control clock input
SCLK	21	DI	5-V	Pulldown	Serial audio data clock (shift clock). SCLK is the serial audio port input data bit clock.
SDA	23	DIO	5-V		I <sup>2</sup> C serial control data interface input/output
SDIN	22	DI	5-V	Pulldown	Serial audio data input. SDIN supports three discrete (stereo) data formats.
SSTIMER	6	AI			Controls ramp time of OUT_x to minimize pop. Leave this pin floating for BD mode. Requires capacitor of 2.2 nF to GND in AD mode. The capacitor determines the ramp time.
STEST	26	DI			Factory test pin. Connect directly to DVSS.
VR_ANA	12	Р			Internally regulated 1.8-V analog supply voltage. This pin must not be used to power external devices.
VR_DIG	18	Р			Internally regulated 1.8-V digital supply voltage. This pin must not be used to power external devices.
VREG	31	Р			Digital regulator output. Not to be used for powering external circuitry.



#### ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

		VALUE	UNIT
Supply voltage       PV         Input voltage       00         3.3       5-\         5-\       5-\         0UT_x to PGND_x       BST_x to PGND_x         Input clamp current, I <sub>IK</sub> Output clamp current, I         Operating free-air temp       Operating junction tem	DVDD, AVDD	-0.3 to 3.6	V
	PVDD_x	-0.3 to 30	V
	OC_ADJ	-0.3 to 4.2	V
land to the sec	3.3-V digital input	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	V
Input voltage	5-V tolerant <sup>(2)</sup> digital input (except MCLK)	-0.5 to DVDD + 2.5 <sup>(3)</sup>	V
	5-V tolerant MCLK input	-0.5 to AVDD + 2.5 <sup>(3)</sup>	V
OUT_x to PGNE	)_x	32 <sup>(4)</sup>	V
BST_x to PGND	)_x	43 <sup>(4)</sup>	V
Input clamp curr	ent, I <sub>IK</sub>	±20	mA
Output clamp cu	irrent, I <sub>OK</sub>	±20	mA
Operating free-a	ir temperature	0 to 85	°C
Operating junction	on temperature range	0 to 150	°C
Storage tempera	ature range, T <sub>stg</sub>	-40 to 125	°C

(1) Stresses beyond those listed under absolute ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under recommended operation conditions are not implied. Exposure to absolute-maximum conditions for extended periods may affect device reliability. 5-V tolerant inputs are PDN, RESET, SCLK, LRCLK, MCLK, SDIN, SDA, and SCL.

Maximum pin voltage should not exceed 6.0V (3)

DC voltage + peak ac waveform measured at the pin should be below the allowed limit for all conditions. (4)

#### THERMAL INFORMATION

	THERMAL METRIC <sup>(1)(2)</sup>	TAS5711	
			UNITS
$\theta_{JA}$	Junction-to-ambient thermal resistance	29.9	
$\theta_{\text{JCtop}}$	Junction-to-case (top) thermal resistance	20.5	
$\theta_{JB}$	Junction-to-board thermal resistance	12.5	°C/W
τιΨ	Junction-to-top characterization parameter	0.3	C/VV
ΨJB	Junction-to-board characterization parameter	7.3	
$\theta_{\text{JCbot}}$	Junction-to-case (bottom) thermal resistance	0.7	

For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953. (1)

For thermal estimates of this device based on PCB copper area, see the TI PCB Thermal Calculator. (2)

## **RECOMMENDED OPERATING CONDITIONS**

			MIN	NOM	MAX	UNIT
	Digital/analog supply voltage	DVDD, AVDD	3	3.3	3.6	V
	Half-bridge supply voltage	PVDD_x	8		26	V
V <sub>IH</sub>	High-level input voltage	5-V tolerant	2			V
VIL	Low-level input voltage	5-V tolerant			0.8	V
T <sub>A</sub>	Operating ambient temperature range		0		85	°C
T <sub>J</sub> <sup>(1)</sup>	Operating junction temperature range		0		125	°C
R <sub>L</sub> (BTL)	Load impedance	Output filter: L = 15 $\mu$ H, C = 680 nF.	6	8		Ω
L <sub>O</sub> (BTL)	Output-filter inductance	Minimum output inductance under short-circuit condition	10			μΗ

(1) Continuous operation above the recommended junction temperature may result in reduced reliability and/or lifetime of the device.



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#### **PWM OPERATION AT RECOMMENDED OPERATING CONDITIONS**

PARAMETER	TEST CONDITIONS	VALUE	UNIT
	11.025/22.05/44.1-kHz data rate ±2%	352.8	kHz
Output sample rate	48/24/12/8/16/32-kHz data rate ±2%	384	

#### PLL INPUT PARAMETERS AND EXTERNAL FILTER COMPONENTS

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>MCLKI</sub>	MCLK Frequency		2.8224		24.576	MHz
	MCLK duty cycle		40%	50%	60%	
tr / tf <sub>(MCLK)</sub>	Rise/fall time for MCLK				5	ns
	LRCLK allowable drift before LRCLK reset				4	MCLKs
	External PLL filter capacitor C1	SMD 0603 X7R		47		nF
	External PLL filter capacitor C2	SMD 0603 X7R		4.7		nF
	External PLL filter resistor R	SMD 0603, metal film		470		Ω

## **ELECTRICAL CHARACTERISTICS**

#### **DC Characteristics**

TA = 25°, PVCC\_x = 18V, DVDD = AVDD = 3.3V, R<sub>L</sub>= 8Ω, BTL AD Mode, FS = 48KHz (unless otherwise noted)

	PARAMETER	र	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>OH</sub>	High-level output voltage	A_SEL and SDA	I <sub>OH</sub> = -4 mA DVDD = AVDD = 3 V	2.4			V
V <sub>OL</sub>	Low-level output voltage	A_SEL and SDA	I <sub>OL</sub> = 4 mA DVDD = AVDD = 3 V			0.5	V
I <sub>IL</sub>	Low-level input current		$V_{I} < V_{IL}$ ; DVDD = AVDD = 3.6V			75	μA
I <sub>IH</sub>	High-level input current		$V_I > V_{IH}$ ; DVDD = AVDD = 3.6V			75 <sup>(1)</sup>	μA
		2.2.V eurolis veltage (DV/DD	Normal Mode		48	70	
I <sub>DD</sub>	3.3 V supply current	3.3 V supply voltage (DVDD, AVDD)	$\frac{\text{Reset}}{\text{PDN}} = \text{high})$		24	32	mA
			Normal Mode		30	55	
I <sub>PVDD</sub>	Half-bridge supply current	No load (PVDD_x)	$\frac{\text{Reset}}{\text{PDN}} = \text{high})$		5	13 mA	mA
	Drain-to-source resistance, LS $T_J = 25^{\circ}$ C, includes metallization resistance				180		
r <sub>DS(on)</sub> <sup>(2)</sup>	Drain-to-source resistance, HS	T <sub>J</sub> = 25°C, includes metallization	n resistance		180		mΩ
I/O Protectio	on						
V <sub>uvp</sub>	Undervoltage protection limit	PVDD falling			7.2		V
V <sub>uvp,hyst</sub>	Undervoltage protection limit	PVDD rising			7.6		V
OTE <sup>(3)</sup>	Overtemperature error				150		°C
OTE <sub>HYST</sub> <sup>(3)</sup>	Extra temperature drop required to recover from error				30		°C
OLPC	Overload protection counter	f <sub>PWM</sub> = 384 kHz			0.63		ms
loc	Overcurrent limit protection	Resistor-programmable, max.	current, $R_{OCP} = 22 \text{ k}\Omega$		4.5		А
I <sub>OCT</sub>	Overcurrent response time				150		ns
R <sub>OCP</sub>	OC programming resistor range	Resistor tolerance = 5% for typic resistance should not be less the		20	22		kΩ
R <sub>PD</sub>	Internal pulldown resistor at the output of each half-bridge	Connected when drivers are tris capacitor charge.	tated to provide bootstrap		3		kΩ

(1)  $I_{IH}$  for the PBTL pin has a maximum limit of 200  $\mu$ A due to an intenal pulldown on the pin.

(2) This does not include bond-wire or pin resistance.

(3) Specified by design

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## AC Characteristics (BTL)

PVDD\_x = 18 V, BTL AD mode, FS = 48 KHz,  $R_L = 8 \Omega$ ,  $R_{OCP} = 22 K\Omega$ ,  $C_{BST} = 33 nF$ , audio frequency = 1 kHz, AES17 filter,  $f_{PWM} = 384 \text{ kHz}$ ,  $T_A = 25^{\circ}C$  (unless otherwise specified). All performance is in accordance with recommended operating conditions (unless otherwise specified).

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
		PVDD = 18 V, 10% THD, 1-kHz input signal	21		
		PVDD = 18 V, 7% THD, 1-kHz input signal	20		
		PVDD = 12 V, 10% THD, 1-kHz input signal	9.5		
		PVDD = 12 V, 7% THD, 1-kHz input signal	9		
		PVDD = 8 V, 10% THD, 1-kHz input signal	4.1		
		PVDD = 8 V, 7% THD, 1-kHz input signal	3.9		
		PBTL mode, PVDD = 12 V, $R_L = 4 \Omega$ , 10% THD, 1-kHz input signal	19.2		
		PBTL mode, PVDD = 12 V, $R_L = 4 \Omega$ , 7% THD, 1-kHz input signal	18		
Po	Power output per channel	PBTL mode, PVDD = 18 V, $R_L = 4 \Omega$ , 10% THD, 1-kHz input signal	42.8		W
		PBTL mode, PVDD = 18 V, $R_L = 4 \Omega$ , 7% THD, 1-kHz input signal	40		
		SE mode, PVDD = 12 V, $R_L = 4 \Omega$ , 10% THD, 1-kHz input signal	4.6		
		SE mode, PVDD = 12 V, $R_L = 4 \Omega$ , 7% THD, 1-kHz input signal	4.3		
		SE mode, PVDD = 24 V, $R_L = 4 \Omega$ , 10% THD, 1-kHz input signal	17.8		
		SE mode, PVDD = 24 V, $R_L = 4 \Omega$ , 7% THD, 1-kHz input signal	16		
		PVDD = 18 V, P <sub>O</sub> = 1 W	0.06%		
THD+N	Total harmonic distortion + noise	PVDD = 12 V, P <sub>O</sub> = 1 W	0.08%		
		PVDD = 8 V, P <sub>O</sub> = 1 W	0.2%		
V <sub>n</sub>	Output integrated noise (rms)	A-weighted	44		μV
	Createlly	P <sub>O</sub> = 0.25 W, f = 1 kHz (BD Mode)	-82		dB
	Crosstalk	P <sub>O</sub> = 0.25 W, f = 1 kHz (AD Mode)	-69		dB
SNR	Signal-to-noise ratio <sup>(1)</sup>	A-weighted, f = 1 kHz, maximum power at THD < 1%	106		dB

(1) SNR is calculated relative to 0-dBFS input level.



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# SERIAL AUDIO PORTS SLAVE MODE

over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	МАХ	UNIT
f <sub>SCLKIN</sub>	Frequency, SCLK 32 × $f_S$ , 48 × $f_S$ , 64 × $f_S$	C <sub>L</sub> = 30 pF	1.024		12.288	MHz
t <sub>su1</sub>	Setup time, LRCLK to SCLK rising edge		10			ns
t <sub>h1</sub>	Hold time, LRCLK from SCLK rising edge		10			ns
t <sub>su2</sub>	Setup time, SDIN to SCLK rising edge		10			ns
t <sub>h2</sub>	Hold time, SDIN from SCLK rising edge		10			ns
	LRCLK frequency		8	48	48	kHz
	SCLK duty cycle		40%	50%	60%	
	LRCLK duty cycle		40%	50%	60%	
	SCLK rising edges between LRCLK rising edges		32		64	SCLK edges
t <sub>(edge)</sub>	LRCLK clock edge with respect to the falling edge of SCLK		-1/4		1/4	SCLK period
t <sub>r</sub> /t <sub>f</sub>	Rise/fall time for SCLK/LRCLK				8	ns

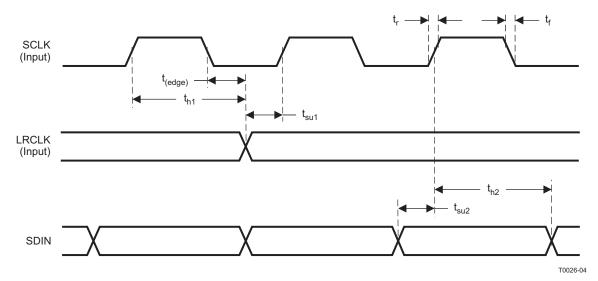


Figure 2. Slave Mode Serial Data Interface Timing



# I<sup>2</sup>C SERIAL CONTROL PORT OPERATION

Timing characteristics for I<sup>2</sup>C Interface signals over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
f <sub>SCL</sub>	Frequency, SCL	No wait states		400	kHz
t <sub>w(H)</sub>	Pulse duration, SCL high		0.6		μS
t <sub>w(L)</sub>	Pulse duration, SCL low		1.3		μS
t <sub>r</sub>	Rise time, SCL and SDA			300	ns
t <sub>f</sub>	Fall time, SCL and SDA			300	ns
t <sub>su1</sub>	Setup time, SDA to SCL		100		ns
t <sub>h1</sub>	Hold time, SCL to SDA		0		ns
t <sub>(buf)</sub>	Bus free time between stop and start condition		1.3		μS
t <sub>su2</sub>	Setup time, SCL to start condition		0.6		μS
t <sub>h2</sub>	Hold time, start condition to SCL		0.6		μS
t <sub>su3</sub>	Setup time, SCL to stop condition		0.6		μS
CL	Load capacitance for each bus line			400	pF

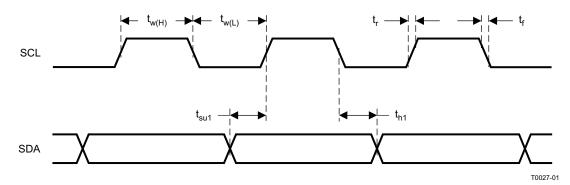


Figure 3. SCL and SDA Timing

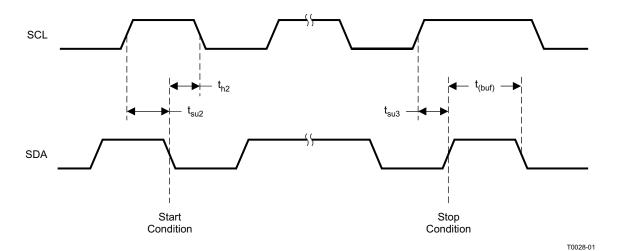


Figure 4. Start and Stop Conditions Timing

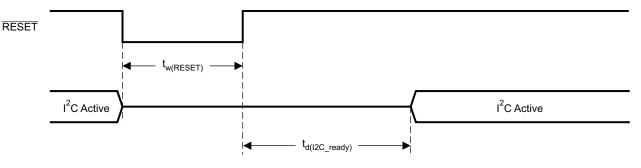


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## **RESET TIMING (RESET)**

Control signal parameters over recommended operating conditions (unless otherwise noted). Please refer to Recommended Use Model section on usage of all terminals.

	PARAMETER	MIN	TYP	MAX	UNIT
t <sub>w(RESET)</sub>	Pulse duration, RESET active	100			μs
t <sub>d(I2C_ready)</sub>	Time to enable I <sup>2</sup> C			12.0	ms



System Initialization. Enable via I<sup>2</sup>C.

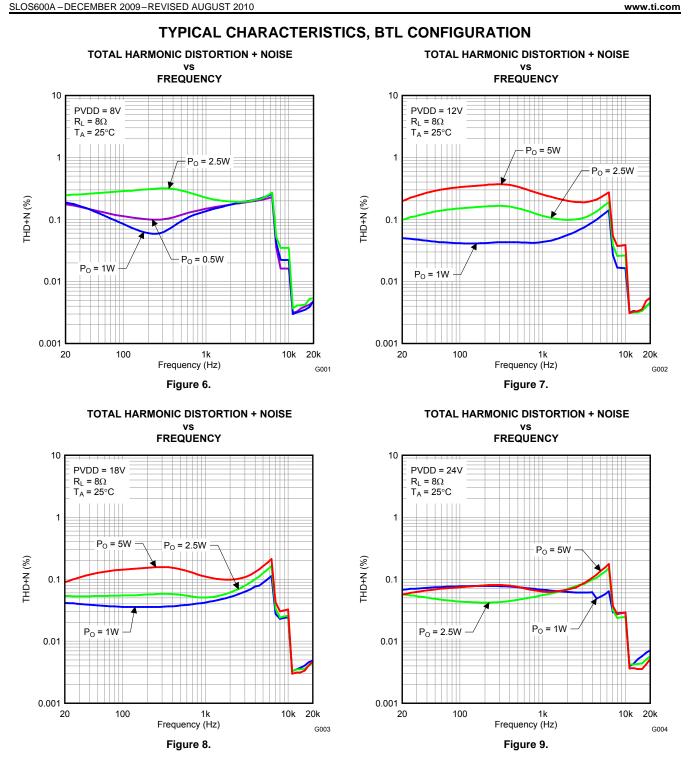
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NOTES: On power up, it is recommended that the TAS5711 RESET be held LOW for at least 100 µs after DVDD has reached 3 V.

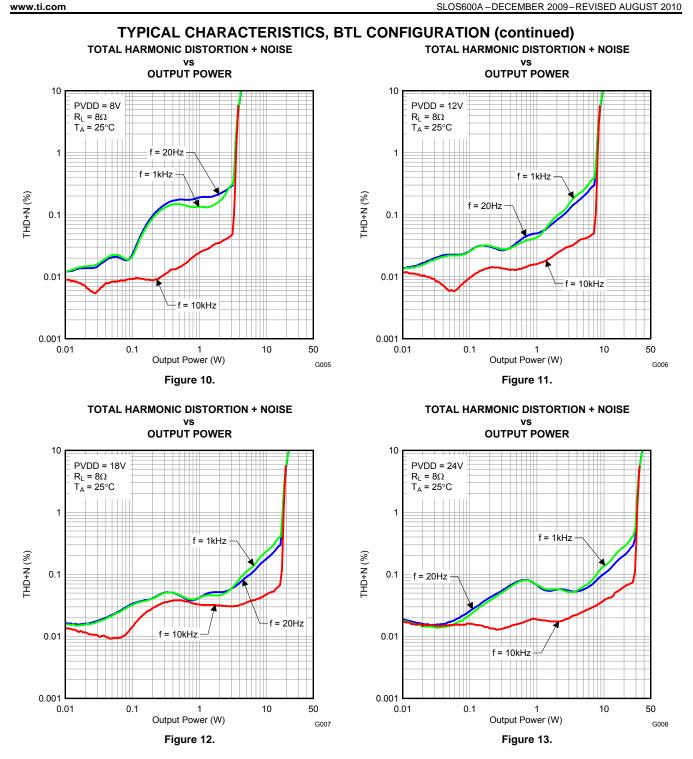
If the  $\overline{\text{RESET}}$  is asserted LOW while  $\overline{\text{PDN}}$  is LOW, then the  $\overline{\text{RESET}}$  must continue to be held LOW for at least 100 µs after  $\overline{\text{PDN}}$  is deasserted (HIGH).

#### Figure 5. Reset Timing

**EXAS** NSTRUMENTS



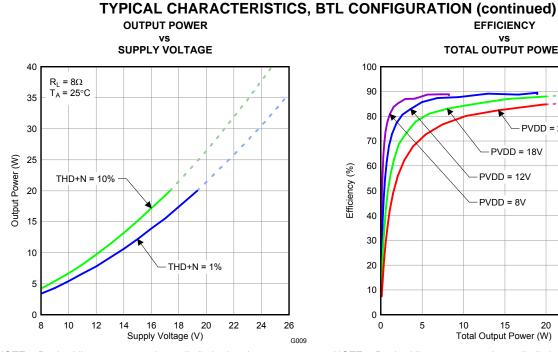


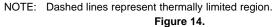


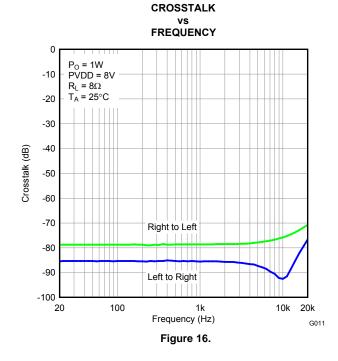
**FEXAS** NSTRUMENTS

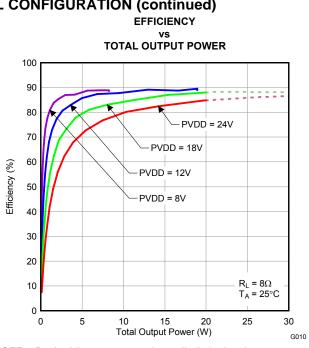
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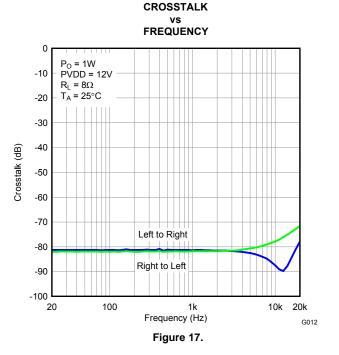




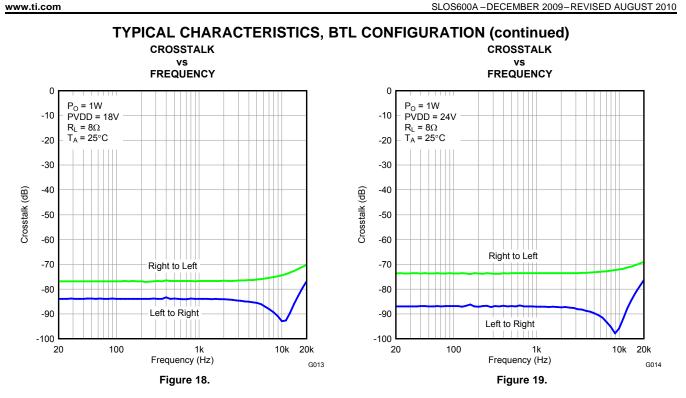




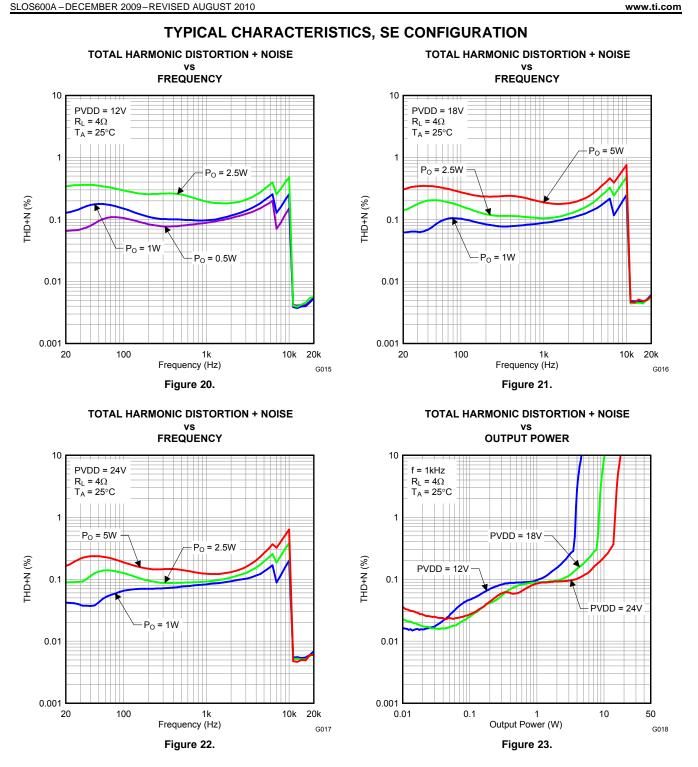
NOTE: Dashed lines represent thermally limited region. Figure 15.



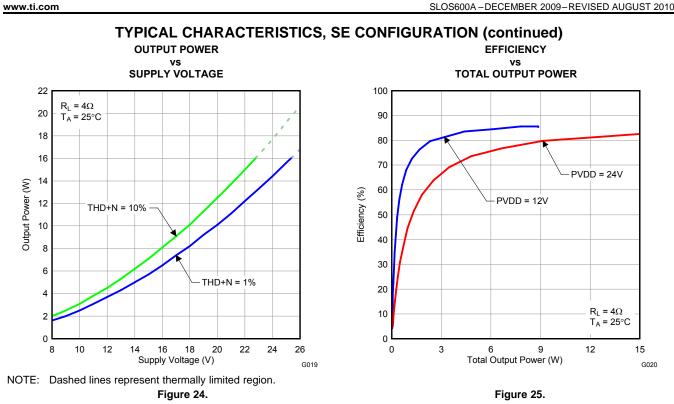




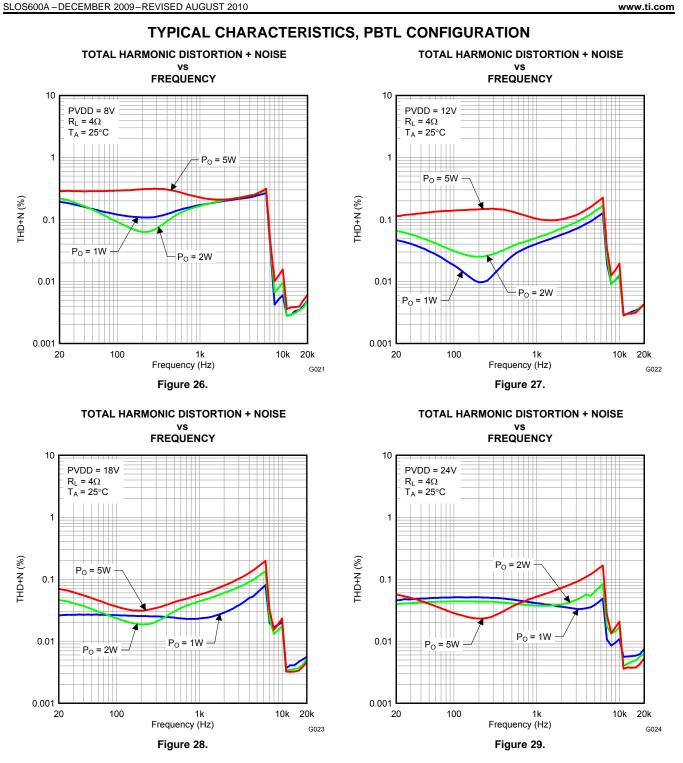
**FEXAS** NSTRUMENTS







**Texas** NSTRUMENTS





**EXAS** 

**INSTRUMENTS** 

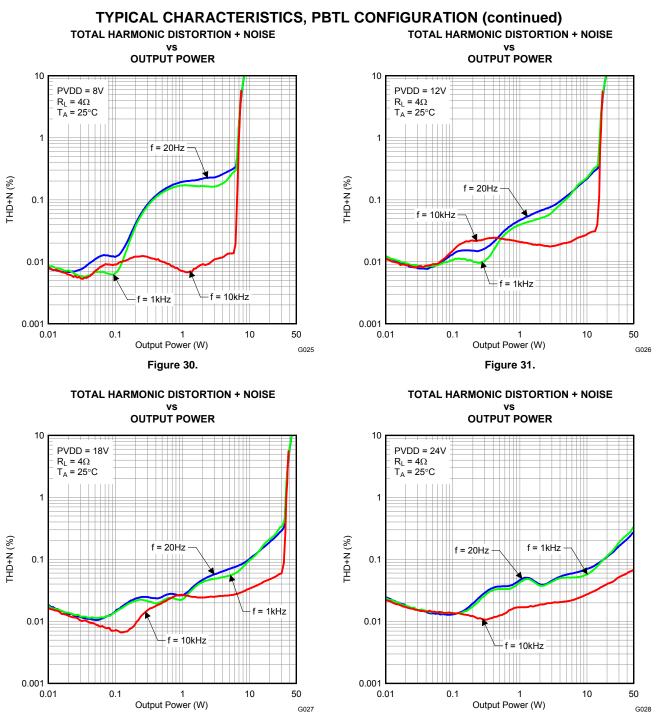
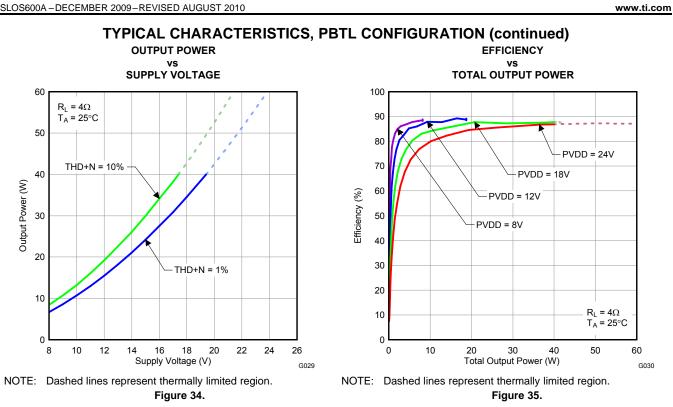


Figure 33.

Figure 32.

ÈXAS NSTRUMENTS





## DETAILED DESCRIPTION

#### POWER SUPPLY

To facilitate system design, the TAS5711 needs only a 3.3-V supply in addition to the (typical) 18-V power-stage supply. An internal voltage regulator provides suitable voltage levels for the gate drive circuitry. Additionally, all circuitry requiring a floating voltage supply, e.g., the high-side gate drive, is accommodated by built-in bootstrap circuitry requiring only a few external capacitors.

In order to provide good electrical and acoustical characteristics, the PWM signal path for the output stage is designed as identical, independent half-bridges. For this reason, each half-bridge has separate bootstrap pins (BST\_x), and power-stage supply pins (PVDD\_x). The gate drive voltages (GVDD\_AB and GVDD\_CD) are derived from the PVDD voltage. Special attention should be paid to placing all decoupling capacitors as close to their associated pins as possible. In general, inductance between the power-supply pins and decoupling capacitors must be avoided.

For a properly functioning bootstrap circuit, a small ceramic capacitor must be connected from each bootstrap pin (BST\_x) to the power-stage output pin (OUT\_x). When the power-stage output is low, the bootstrap capacitor is charged through an internal diode connected between the gate-drive regulator output pin (GVDD\_x) and the bootstrap pin. When the power-stage output is high, the bootstrap capacitor potential is shifted above the output potential and thus provides a suitable voltage supply for the high-side gate driver. In an application with PWM switching frequencies in the range from 352 kHz to 384 kHz, it is recommended to use 33-nF 50-V X7R capacitors, size 0603 or 0805, for the bootstrap supply. These 33-nF capacitors ensure sufficient energy storage, even during minimal PWM duty cycles, to keep the high-side power stage FET (LDMOS) fully turned on during the remaining part of the PWM cycle.

Special attention should be paid to the power-stage power supply; this includes component selection, PCB placement, and routing. As indicated, each half-bridge has independent power-stage supply pins (PVDD\_x). For optimal electrical performance, EMC compliance, and system reliability, it is important that each PVDD\_x pin is decoupled with a 100-nF ceramic capacitor placed as close as possible to each supply pin.

The TAS5711 is fully protected against erroneous power-stage turnon due to parasitic gate charging.

#### ERROR REPORTING

The A\_SEL pin has two functions:  $I^2C$  device-address select and fault indication. On RESET, this pin is an input and defines the  $I^2C$  address. But this pin can be programmed after RESET to be an output by writing 1 to bit 0 of  $I^2C$  register 0x05. In that mode, the A\_SEL pin has the definition shown in Table 1.

Any fault resulting in device shutdown is signaled by the A\_SEL pin going low (see Table 1). A latched version of this pin is available on D1 of register 0x02. The bit can be cleared only by an I<sup>2</sup>C write.

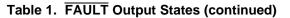
FAULT	DESCRIPTION
0	Overcurrent (OC) or undervoltage (UVP) error or overtemperature error (OTE) or over voltage ERROR
1	No faults (normal operation)

#### Table 1. FAULT Output States

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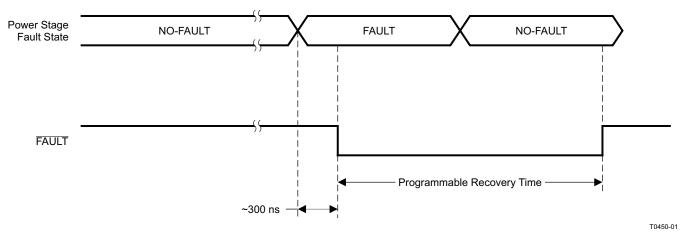


Figure 36. Fault Timing Diagram

### **DEVICE PROTECTION SYSTEM**

#### **Overcurrent (OC) Protection With Current Limiting**

The device has independent, fast-reacting current detectors on all high-side and low-side power-stage FETs. The detector outputs are closely monitored by two protection systems. The first protection system controls the power stage in order to prevent the output current further increasing, i.e., it performs a cycle-by-cycle current-limiting function, rather than prematurely shutting down during combinations of high-level music transients and extreme speaker load impedance drops. If the high-current condition situation persists, i.e., the power stage is being overloaded, a second protection system triggers a latching shutdown, resulting in the power stage being set in the high-impedance (Hi-Z) state. The device returns to normal operation once the fault condition (i.e., a short circuit on the output) is removed. Current limiting and overcurrent protection are not independent for half-bridges. That is, if the bridge-tied load between half-bridges A and B causes an overcurrent fault, half-bridges A, B, C, and D are shut down.

#### **Overtemperature Protection**

The TAS5711 has over temperature-protection system. If the device junction temperature exceeds 150°C (nominal), the device is put into thermal shutdown, resulting in all half-bridge outputs being set in the high-impedance (Hi-Z) state and FAULT being asserted low. The TAS5711 recovers automatically once the temperature drops approximately 30°.

#### Undervoltage Protection (UVP) and Power-On Reset (POR)

The UVP and POR circuits of the TAS5711 fully protect the device in any power-up/down and brownout situation. While powering up, the POR circuit resets the overload circuit and ensures that all circuits are fully operational when the PVDD and AVDD supply voltages reach 7.6 V and 2.7 V, respectively. Although PVDD and AVDD are independently monitored, a supply voltage drop below the UVP threshold on AVDD <u>or either</u> PVDD pin results in all half-bridge outputs immediately being set in the high-impedance (Hi-Z) state and FAULT being asserted low.

#### SSTIMER FUNCTIONALITY

The SSTIMER pin uses a capacitor connected between this pin and ground to control the output duty cycle when exiting all-channel shutdown. The capacitor on the SSTIMER pin is slowly charged through an internal current source, and the charge time determines the rate at which the output transitions from a near zero duty cycle to the desired duty cycle. This allows for a smooth transition that minimizes audible pops and clicks. When the part is shutdown the drivers are tristated and transition slowly down through a 3K resistor, similarly minimizing pops and clicks. The shutdown transition time is independent of SSTIMER pin capacitance. Larger capacitors will increase the start-up time, while capacitors smaller than 2.2 nF will decrease the start-up time. The SSTIMER pin should be left floating for BD modulation (BTL and PBTL modes) and in 2.1 mode.



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#### **CLOCK, AUTO DETECTION, AND PLL**

The TAS5711 is a slave device. It accepts MCLK, SCLK, and LRCLK. The digital audio processor (DAP) supports all the sample rates and MCLK rates that are defined in the clock control register.

The TAS5711 checks to verify that SCLK is a specific value of 32  $f_S$ , 48  $f_S$ , or 64  $f_S$ . The DAP only supports a 1 x  $f_S$  LRCLK. The timing relationship of these clocks to SDIN is shown in subsequent sections. The clock section uses MCLK or the internal oscillator clock (when MCLK is unstable, out of range, or absent) to produce the internal clock (DCLK) running at 512 time the PWM switching frequency.

The DAP can autodetect and set the internal clock control logic to the appropriate settings for all supported clock rates as defined in the clock control register.

TAS5711 has robust clock error handling that uses the bulit-in trimmed oscillator clock to quickly detect changes/errors. Once the system detects a clock change/error, it will mute the audio (through a single step mute) and then force PLL to limp using the internal oscillator as a reference clock. Once the clocks are stable, the system will auto detect the new rate and revert to normal operation. During this process, the default volume will be restored in a single step (also called hard unmute). The ramp process can be programmed to ramp back slowly (also called soft unmute) as defined in volume register (0x0E).

#### SERIAL DATA INTERFACE

Serial data is input on SDIN. The PWM outputs are derived from SDIN. The TAS5711 DAP accepts serial data in 16-, 20-, or 24-bit left-justified, right-justified, and I<sup>2</sup>S serial data formats.

#### **PWM Section**

The TAS5711 DAP device uses noise-shaping and sophisticated non-linear correction algorithms to achieve high power efficiency and high-performance digital audio reproduction. The DAP uses a fourth-order noise shaper to increase dynamic range and SNR in the audio band. The PWM section accepts 24-bit PCM data from the DAP and outputs two BTL PWM audio output channels.

The PWM section has individual channel dc blocking filters that can be enabled and disabled. The filter cutoff frequency is less than 1 Hz. Individual channel de-emphasis filters for 44.1- and 48-kHz are included and can be enabled and disabled.

Finally, the PWM section has an adjustable maximum modulation limit of 93.8% to 99.2%.

For detailed description of using audio processing features like DRC, EQ, 3D, and Bass Boost, please refer to User's Guide and TAS570X GDE software development tool documentation. Also refer to GDE software development tool for device data path.

#### SERIAL INTERFACE CONTROL AND TIMING

The  $I^2S$  mode is set by writing to register 0x04.

#### I<sup>2</sup>S Timing

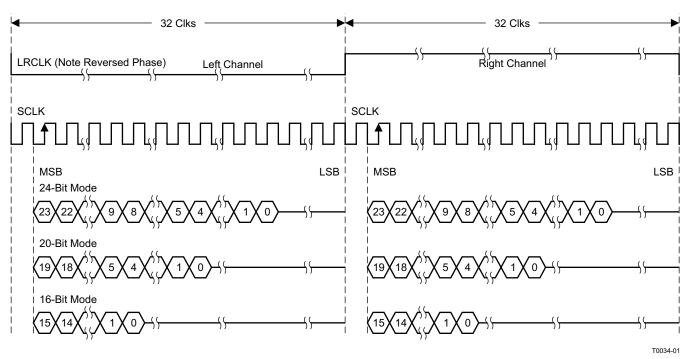
 $I^2S$  timing uses LRCLK to define when the data being transmitted is for the left channel and when it is for the right channel. LRCLK is low for the left channel and high for the right channel. A bit clock running at 32, 48, or 64 × f<sub>S</sub> is used to clock in the data. There is a delay of one bit clock from the time the LRCLK signal changes state to the first bit of data on the data lines. The data is written MSB first and is valid on the rising edge of bit clock. The DAP masks unused trailing data bit positions.

Instruments

Texas

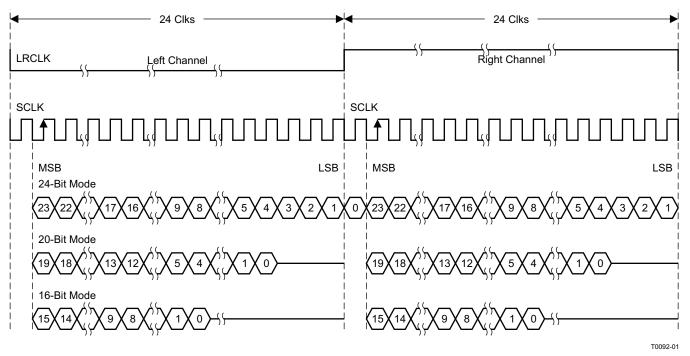
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2-Channel I<sup>2</sup>S (Philips Format) Stereo Input



NOTE: All data presented in 2s-complement form with MSB first.

Figure 37. I<sup>2</sup>S 64-f<sub>S</sub> Format



2-Channel I<sup>2</sup>S (Philips Format) Stereo Input/Output (24-Bit Transfer Word Size)

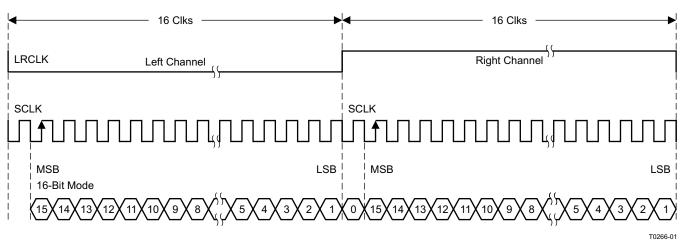
Figure 38. I<sup>2</sup>S 48-f<sub>S</sub> Format

NOTE: All data presented in 2s-complement form with MSB first.



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2-Channel I<sup>2</sup>S (Philips Format) Stereo Input



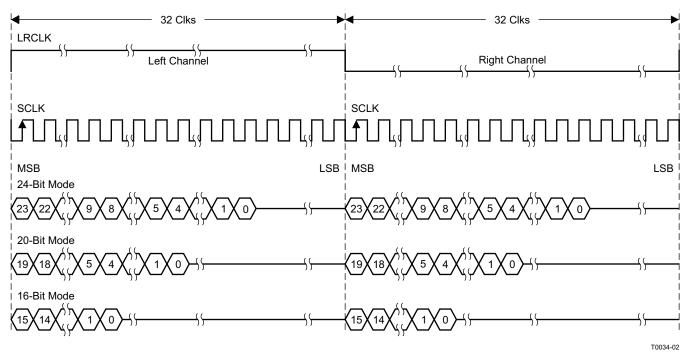
NOTE: All data presented in 2s-complement form with MSB first.

#### Figure 39. I<sup>2</sup>S 32-f<sub>S</sub> Format

#### Left-Justified

Left-justified (LJ) timing uses LRCLK to define when the data being transmitted is for the left channel and when it is for the right channel. LRCLK is high for the left channel and low for the right channel. A bit clock running at 32, 48, or  $64 \times f_S$  is used to clock in the data. The first bit of data appears on the data lines at the same time LRCLK toggles. The data is written MSB first and is valid on the rising edge of the bit clock. The DAP masks unused trailing data bit positions.

2-Channel Left-Justified Stereo Input



NOTE: All data presented in 2s-complement form with MSB first.

#### Figure 40. Left-Justified 64-f<sub>S</sub> Format

# TAS5711

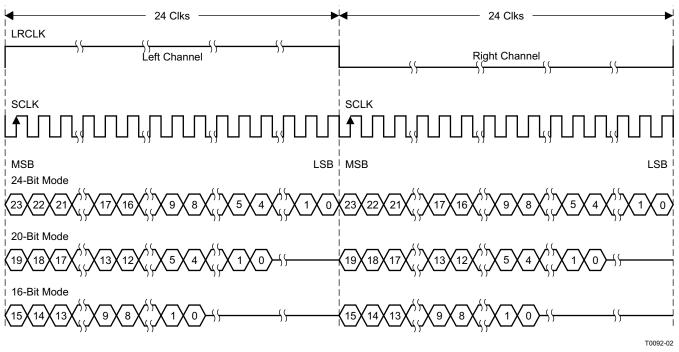
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**ISTRUMENTS** 

**EXAS** 

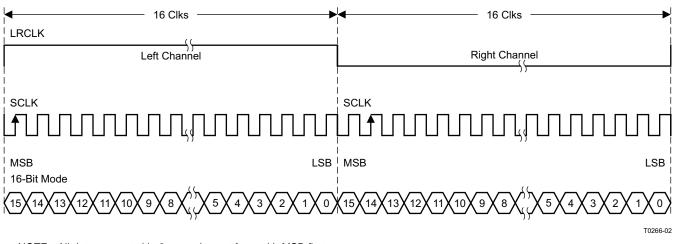
2-Channel Left-Justified Stereo Input (24-Bit Transfer Word Size)



NOTE: All data presented in 2s-complement form with MSB first.

#### Figure 41. Left-Justified 48-f<sub>s</sub> Format

2-Channel Left-Justified Stereo Input



NOTE: All data presented in 2s-complement form with MSB first.

Figure 42. Left-Justified 32-f<sub>S</sub> Format

## **Right-Justified**

Right-justified (RJ) timing uses LRCLK to define when the data being transmitted is for the left channel and when



it is for the right channel. LRCLK is high for the left channel and low for the right channel. A bit clock running at 32, 48, or  $64 \times f_S$  is used to clock in the data. The first bit of data appears on the data 8 bit-clock periods (for 24-bit data) after LRCLK toggles. In RJ mode the LSB of data is always clocked by the last bit clock before LRCLK transitions. The data is written MSB first and is valid on the rising edge of bit clock. The DAP masks unused leading data bit positions.

2-Channel Right-Justified (Sony Format) Stereo Input

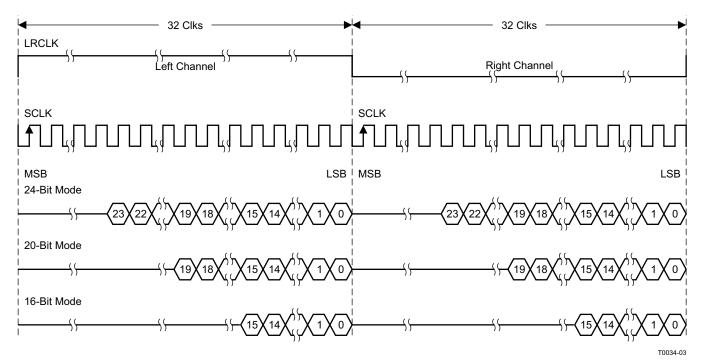


Figure 43. Right Justified 64-f<sub>s</sub> Format

# TAS5711

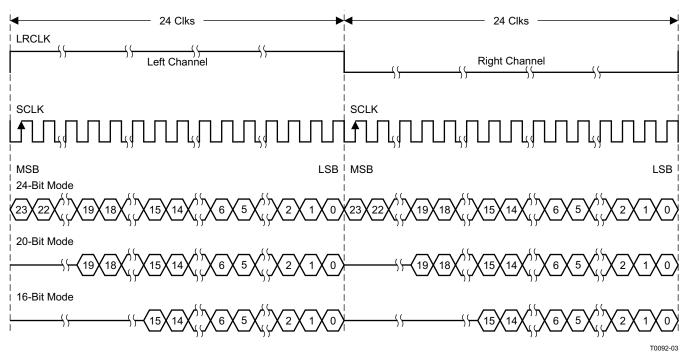
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**ISTRUMENTS** 

**FEXAS** 

2-Channel Right-Justified Stereo Input (24-Bit Transfer Word Size)





2-Channel Right-Justified (Sony Format) Stereo Input

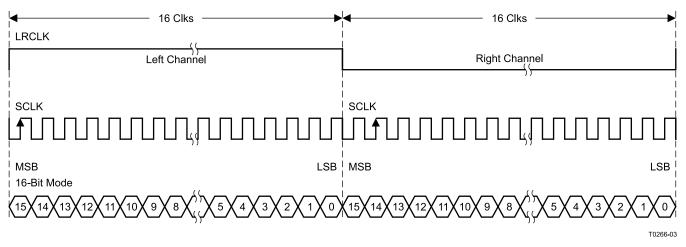


Figure 45. Right Justified 32-f<sub>S</sub> Format



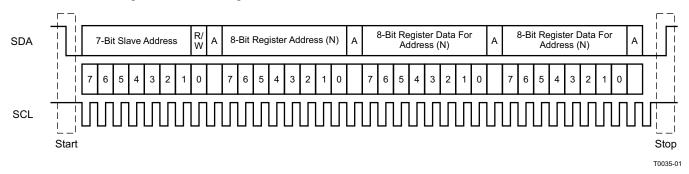
### I<sup>2</sup>C SERIAL CONTROL INTERFACE

The TAS5711 DAP has a bidirectional  $I^2C$  interface that compatible with the  $I^2C$  (Inter IC) bus protocol and supports both 100-kHz and 400-kHz data transfer rates for single and multiple byte write and read operations. This is a slave only device that does not support a multimaster bus environment or wait state insertion. The control interface is used to program the registers of the device and to read device status.

The DAP supports the standard-mode  $I^2C$  bus operation (100 kHz maximum) and the fast  $I^2C$  bus operation (400 kHz maximum). The DAP performs all  $I^2C$  operations without  $I^2C$  wait cycles.

#### General I<sup>2</sup>C Operation

The I<sup>2</sup>C bus employs two signals; SDA (data) and SCL (clock), to communicate between integrated circuits in a system. Data is transferred on the bus serially one bit at a time. The address and data can be transferred in byte (8-bit) format, with the most significant bit (MSB) transferred first. In addition, each byte transferred on the bus is acknowledged by the receiving device with an acknowledge bit. Each transfer operation begins with the master device driving a start condition on the bus and ends with the master device driving a stop condition on the bus and ends with the master device driving a stop condition on the data pin (SDA) while the clock is high to indicate a start and stop conditions. A high-to-low transition on SDA indicates a start and a low-to-high transition indicates a stop. Normal data bit transitions must occur within the low time of the clock period. These conditions are shown in Figure 46. The master generates the 7-bit slave address and the read/write (R/W) bit to open communication with another device and then waits for an acknowledge condition. The TAS5711 holds SDA low during the acknowledge clock period to indicate an acknowledgment. When this occurs, the master transmits the next byte of the sequence. Each device is addressed by a unique 7-bit slave address plus R/W bit (1 byte). All compatible devices share the same signals via a bidirectional bus using a wired-AND connection. An external pullup resistor must be used for the SDA and SCL signals to set the high level for the bus.



#### Figure 46. Typical I<sup>2</sup>C Sequence

There is no limit on the number of bytes that can be transmitted between start and stop conditions. When the last word transfers, the master generates a stop condition to release the bus. A generic data transfer sequence is shown in Figure 46.

Pin  $\overline{A\_SEL}$  defines the I<sup>2</sup>C device address. An external 15-k $\Omega$  pulldown on this pin gives a device address of 0x34 and a 15-k $\Omega$  pullup gives a device address of 0x36. The 7-bit address is 0011011 (0x36) or 0011010 (0x34).

#### I<sup>2</sup>C Device Address Change Procedure

- Write to device address change enable register, 0xF8 with a value of 0xF9 A5 A5 A5.
- Write to device register 0xF9 with a value of 0x0000 00XX, where XX is the new address.
- Any writes after that should use the new device address XX.

#### Single- and Multiple-Byte Transfers

The serial control interface supports both single-byte and multiple-byte read/write operations for subaddresses 0x00 to 0x1F. However, for the subaddresses 0x20 to 0xFF, the serial control interface supports only multiple-byte read/write operations (in multiples of 4 bytes).



During multiple-byte read operations, the DAP responds with data, a byte at a time, starting at the subaddress assigned, as long as the master device continues to respond with acknowledges. If a particular subaddress does not contain 32 bits, the unused bits are read as logic 0.

During multiple-byte write operations, the DAP compares the number of bytes transmitted to the number of bytes that are required for each specific subaddress. For example, if a write command is received for a biquad subaddress, the DAP expects to receive five 32-bit words. If fewer than five 32-bit data words have been received when a stop command (or another start command) is received, the data received is discarded.

Supplying a subaddress for each subaddress transaction is referred to as random I<sup>2</sup>C addressing. The TAS5711 also supports sequential I<sup>2</sup>C addressing. For write transactions, if a subaddress is issued followed by data for that subaddress and the 15 subaddresses that follow, a sequential I<sup>2</sup>C write transaction has taken place, and the data for all 16 subaddresses is successfully received by the TAS5711. For I<sup>2</sup>C sequential write transactions, the subaddress then serves as the start address, and the amount of data subsequently transmitted, before a stop or start is transmitted, determines how many subaddresses are written. As was true for random addressing, sequential addressing requires that a complete set of data be transmitted. If only a partial set of data is written to the last subaddress, the data for the last subaddress is discarded. However, all other data written is accepted; only the incomplete data is discarded.

#### Single-Byte Write

As shown in Figure 47, a single-byte data write transfer begins with the master device transmitting a start condition followed by the I<sup>2</sup>C device address and the read/write bit. The read/write bit determines the direction of the data transfer. For a write data transfer, the read/write bit will be a 0. After receiving the correct I<sup>2</sup>C device address and the read/write bit, the DAP responds with an acknowledge bit. Next, the master transmits the address byte or bytes corresponding to the TAS5711 internal memory address being accessed. After receiving the address byte, the TAS5711 again responds with an acknowledge bit. Next, the master device transmits the data byte to be written to the memory address being accessed. After receiving the data byte, the TAS5711 again responds with an acknowledge bit. The transmits a stop condition to complete the single-byte data write transfer.

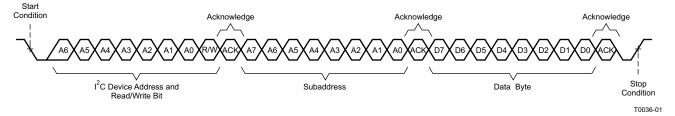


Figure 47. Single-Byte Write Transfer

#### **Multiple-Byte Write**

A multiple-byte data write transfer is identical to a single-byte data write transfer except that multiple data bytes are transmitted by the master device to the DAP as shown in Figure 48. After receiving each data byte, the TAS5711 responds with an acknowledge bit.

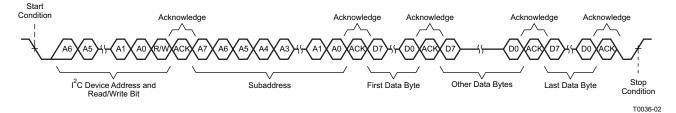


Figure 48. Multiple-Byte Write Transfer



TAS5711

#### Single-Byte Read

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As shown in Figure 49, a single-byte data read transfer begins with the master device transmitting a start condition followed by the I<sup>2</sup>C device address and the read/write bit. For the data read transfer, both a write followed by a read are actually done. Initially, a write is done to transfer the address byte or bytes of the internal memory address to be read. As a result, the read/write bit becomes a 0. After receiving the TAS5711 address and the read/write bit, TAS5711 responds with an acknowledge bit. In addition, after sending the internal memory address byte or bytes, the master device transmits another start condition followed by the TAS5711 address and the read/write bit again. This time the read/write bit becomes a 1, indicating a read transfer. After receiving the address and the read/write bit, the TAS5711 again responds with an acknowledge bit. Next, the TAS5711 transmits the data byte from the memory address being read. After receiving the data byte, the master device transmits a not acknowledge followed by a stop condition to complete the single byte data read transfer.

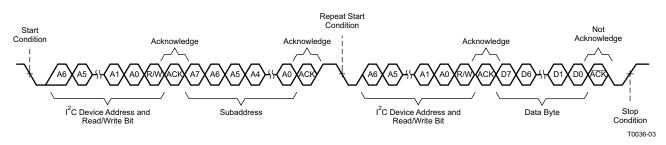


Figure 49. Single-Byte Read Transfer

#### **Multiple-Byte Read**

A multiple-byte data read transfer is identical to a single-byte data read transfer except that multiple data bytes are transmitted by the TAS5711 to the master device as shown in Figure 50. Except for the last data byte, the master device responds with an acknowledge bit after receiving each data byte.

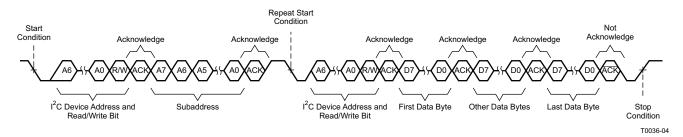


Figure 50. Multiple Byte Read Transfer



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#### **Output Mode and MUX Selection**

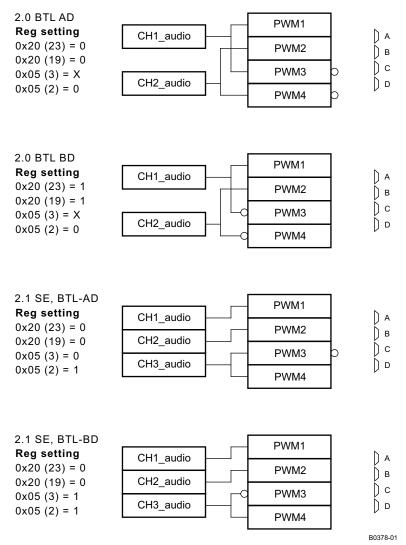


Figure 51. Output Mode and MUX Selection

#### 2.1-Mode Support

The TAS5711 uses a special *mid-Z ramp* sequence to reduce click and pop in SE-mode and 2.1-mode operation. To enable the mid-Z ramp, register 0x05 bit D7 must be set to 1. To enable 2.1 mode, register 0x05 bit D2 must be set to 1. The SSTIMER pin should be left floating in this mode.

## Single-Filter PBTL-Mode Support

The TAS5711 supports parallel BTL (PBTL) mode with OUT\_A/OUT\_B (and OUT\_C/OUT\_D) connected before the LC filter. In order to put the part in PBTL configuration, drive PBTL (pin 8) HIGH. This synchronizes the turnoff of half-bridges A and B (and similarly C/D) if an overcurrent condition is detected in either half-bridge. There is a pulldown resistor on the PBTL pin that configures the part in BTL mode if the pin is left floating.

PWM output multiplexers should be updated to set the device in PBTL mode. Output Mux Register (0x25) should be written with a value of 0x01 10 32 45. Also, the PWM shutdown register (0x19) should be written with a value of 0x3A.



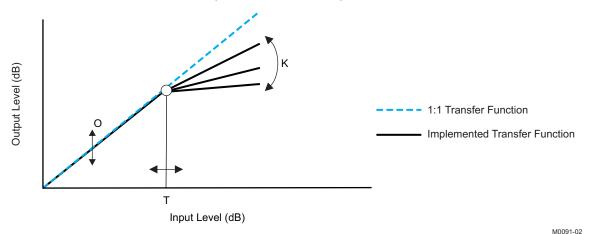
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#### **Dynamic Range Control (DRC)**

The DRC scheme has a single threshold, offset, and slope (all programmable). There is one ganged DRC for the left/right channels and one DRC for the subchannel.

The DRC input/output diagram is shown in Figure 52.

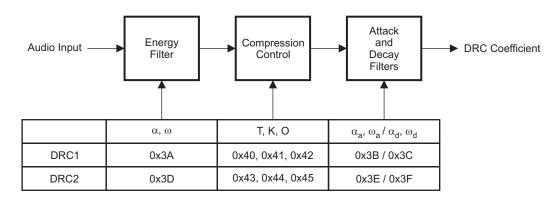
Refer to GDE software tool for more description on T, K, and O parameters.

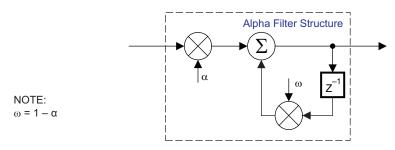


Professional-quality dynamic range compression automatically adjusts volume to flatten volume level.

- · Each DRC has adjustable threshold, offset, and compression levels
- Programmable energy, attack, and decay time constants
- *Transparent compression*: compressors can attack fast enough to avoid apparent clipping before engaging, and decay times can be set slow enough to avoid pumping.







B0265-01

T = 9.23 format, all other DRC coefficients are 3.23 format

#### Figure 53. DRC Structure



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### BANK SWITCHING

The TAS5711 uses an approach called bank switching together with automatic sample-rate detection. All processing features that must be changed for different sample rates are stored internally in three banks. The user can program which sample rates map to each bank. By default, bank 1 is used in 32kHz mode, bank 2 is used in 44.1/48 kHz mode, and bank 3 is used for all other rates. Combined with the clock-rate autodetection feature, bank switching allows the TAS5711 to detect automatically a change in the input sample rate and switch to the appropriate bank without any MCU intervention.

An external controller configures bankable locations (0x29-0x36, 0x3A-0x3F, and 0x58-0x5F) for all three banks during the initialization sequence.

If auto bank switching is enabled (register 0x50, bits 2:0), then the TAS5711 automatically swaps the coefficients for subsequent sample rate changes, avoiding the need for any external controller intervention for a sample rate change.

By default, bits 2:0 have the value 000; indicating that bank switching is disabled. In that state, updates to bankable locations take immediate effect. A write to register 0x50 with bits 2:0 being 001, 010, or 011 brings the system into the coefficient-bank-update state update bank1, update bank2, or update bank3, respectively. Any subsequent write to bankable locations updates the coefficient banks stored outside the DAP. After updating all the three banks, the system controller should issue a write to register 0x50 with bits 2:0 being 100; this changes the system state to automatic bank switching mode. In automatic bank switching mode, the TAS5711 automatically swaps banks based on the sample rate.

COL	nmand sequences for updating DAP coefficients can be summarized as follows:
1.	Bank switching disabled (default): DAP coefficient writes take immediate effect and are not influenced by subsequent sample rate changes.
	OR
	Bank switching enabled:
	(a) Update bank-1 mode: Write "001" to bits 2:0 of reg 0x50. Load the 32 kHz coefficients.
	(b) Update bank-2 mode: Write "010" to bits 2:0 of reg 0x50. Load the 48 kHz coefficients.
	(c) Update bank-3 mode: Write "011" to bits 2:0 of reg 0x50. Load the other coefficients.
	(d) Enable automatic bank switching by writing "100" to bits 2:0 of rog 0x50

(d) Enable automatic bank switching by writing "100" to bits 2:0 of reg 0x50.

#### 26-Bit 3.23 Number Format

All mixer gain coefficients are 26-bit coefficients using a 3.23 number format. Numbers formatted as 3.23 numbers means that there are 3 bits to the left of the decimal point and 23 bits to the right of the decimal point. This is shown in Figure 54.

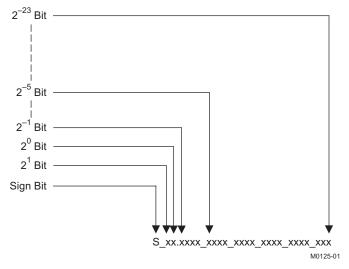


Figure 54. 3.23 Format



The decimal value of a 3.23 format number can be found by following the weighting shown in Figure 54. If the most significant bit is logic 0, the number is a positive number, and the weighting shown yields the correct number. If the most significant bit is a logic 1, then the number is a negative number. In this case every bit must be inverted, a 1 added to the result, and then the weighting shown in Figure 55 applied to obtain the magnitude of the negative number.

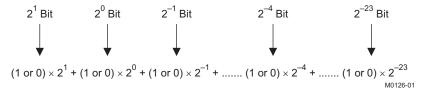
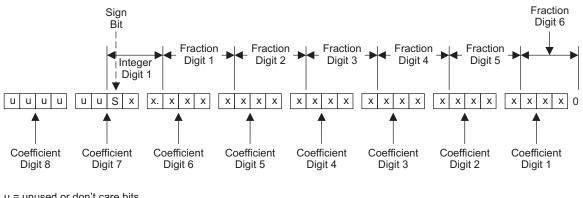


Figure 55. Conversion Weighting Factors—3.23 Format to Floating Point

Gain coefficients, entered via the  $l^2C$  bus, must be entered as 32-bit binary numbers. The format of the 32-bit number (4-byte or 8-digit hexadecimal number) is shown in Figure 56



u = unused or don't care bits Digit = hexadecimal digit

M0127-01



dB	Linear	Decimal	Hex (3.23 Format)
0	1	8,388,608	0080 0000
5	1.7782794	14,917,288	00E3 9EA8
-5	0.5623413	4,717,260	0047 FACC
Х	$L = 10^{(X/20)}$	D = 8,388,608 × L	H = dec2hex (D, 8)

### Table 2. Sample Calculation for 3.23 Format

### Table 3. Sample Calculation for 9.17 Format

dB	Linear	Decimal	Hex (9.17 Format)
0	1	131,072	2 0000
5	1.77	231,997	3 8A3D
-5	0.56	73,400	1 1EB8
Х	$L = 10^{(X/20)}$	D = 131,072 × L	H = dec2hex (D, 8)

- Powerdown

Shutdown

X

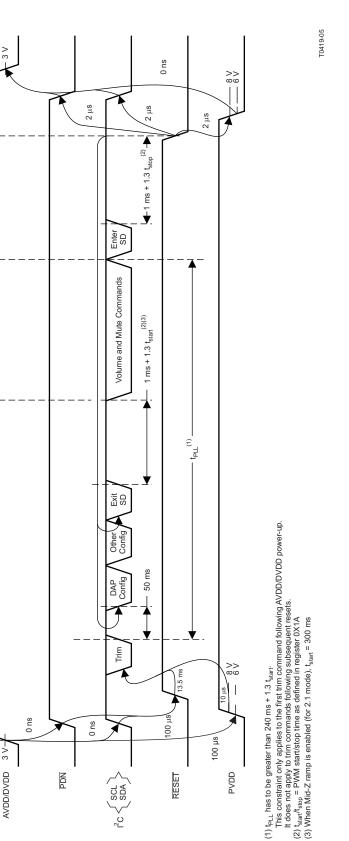
Normal Operation

1

X

Initialization

## **Recommended Use Model**



l²c ∕ Figure 57. Recommended Command Sequence www.ti.com



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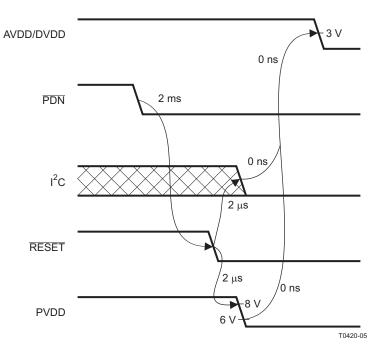


Figure 58. Power Loss Sequence

### **Recommended Command Sequences**

### Initialization Sequence

Use the following sequence to power-up and initialize the device:

- 1. Hold all digital inputs low and ramp up AVDD/DVDD to at least 3 V.
- 2. Initialize digital inputs and PVDD supply as follows:
  - Drive  $\overline{\text{RESET}} = 0$ ,  $\overline{\text{PDN}} = 1$ , and other digital inputs to their desired state while ensuring that all are never more than 2.5 V above AVDD/DVDD. Wait at least 100 µs, drive  $\overline{\text{RESET}} = 1$ , and wait at least another 13.5 ms.
  - Ramp up PVDD to at least 8 V while ensuring that it remains below 6 V for at least 100 µs after AVDD/DVDD reaches 3 V. Then wait at least another 10 µs.
- 3. Trim oscillator (write 0x00 to register 0x1B) and wait at least 50 ms.
- 4. Configure the DAP via I<sup>2</sup>C (see Users's Guide for typical values).
- 5. Configure remaining registers.
- 6. Exit shutdown (sequence defined below).

### **Normal Operation**

The following are the only events supported during normal operation:

- 1. Writes to master/channel volume registers.
- 2. Writes to soft mute register.
- 3. Enter and exit shutdown (sequence defined below).

**Note:** Event 3 is not supported for 240 ms +  $1.3 \times t_{start}$  after trim following AVDD/DVDD powerup ramp (where  $t_{start}$  is 300 ms when mid-Z ramp is enabled and is otherwise specified by register 0x1A).



### Shutdown Sequence

### Enter:

- 1. Write 0x40 to register 0x05.
- 2. Wait at least 1 ms + 1.3 ×  $t_{stop}$  (where  $t_{stop}$  is specified by register 0x1A).
- 3. If desired, reconfigure by returning to step 4 of initialization sequence.

### Exit:

- 1. Write 0x00 to register 0x05 (exit shutdown command may not be serviced for as much as 240 ms after trim following AVDD/DVDD powerup ramp).
- Wait at least 1 ms + 1.3 × t<sub>start</sub> (where t<sub>start</sub> is 300 ms when mid-Z ramp is enabled and is otherwise specified by register 0x1A).
- 3. Proceed with normal operation.

### **Power-Down Sequence**

Use the following sequence to powerdown the device and its supplies:

- 1. If time permits, enter shutdown (sequence defined above); else, in case of sudden power loss, assert PDN = 0 and wait at least 2 ms.
- 2. Assert  $\overline{\text{RESET}} = 0$ .
- 3. Drive digital inputs low and ramp down PVDD supply as follows:
  - Drive all digital inputs low after RESET has been low for at least 2 µs.
  - Ramp down PVDD while ensuring that it remains above 8 V until RESET has been low for at least 2 μs.
- 4. Ramp down AVDD/DVDD while ensuring that it remains above 3 V until PVDD is below 6 V and that it is never more than 2.5 V below the digital inputs.



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# Table 4. Serial Control Interface Register Summary

SUBADDRESS	REGISTER NAME	NO. OF BYTES	CONTENTS	INITIALIZATION VALUE
			A u indicates unused bits.	
0x00	Clock control register	1	Description shown in subsequent section	0x6C
0x01	Device ID register	1	Description shown in subsequent section	0x70
0x02	Error status register	1	Description shown in subsequent section	0x00
0x03	System control register 1	1	Description shown in subsequent section	0xA0
0x04	Serial data interface register	1	Description shown in subsequent section	0x05
0x05	System control register 2	1	Description shown in subsequent section	0x40
0x06	Soft mute register	1	Description shown in subsequent section	0x00
0x07	Master volume	1	Description shown in subsequent section	0xFF (mute)
0x08	Channel 1 vol	1	Description shown in subsequent section	0x30 (0 dB)
0x09	Channel 2 vol	1	Description shown in subsequent section	0x30 (0 dB)
0x0A	Channel 3 vol	1	Description shown in subsequent section	0x30 (0 dB)
0x0B - 0x0D		1	Reserved <sup>(1)</sup>	
0x0E	Volume configuration register	1	Description shown in subsequent section	0x91
0x0F	-	1	Reserved <sup>(1)</sup>	
0x10	Modulation limit register	1	Description shown in subsequent section	0x02
0x11	IC delay channel 1	1	Description shown in subsequent section	0xAC
0x12	IC delay channel 2	1	Description shown in subsequent section	0x54
0x13	IC delay channel 3	1	Description shown in subsequent section	0xAC
0x14	IC delay channel 4	1	Description shown in subsequent section	0x54
0x15-0x18		1	Reserved <sup>(1)</sup>	
0x19	PWM channel shutdown group register	1	Description shown in subsequent section	0x30
0x1A	Start/stop period register	1		0x0F
0x1B	Oscillator trim register	1		0x82
0x1C	BKND_ERR register	1		0x02
0x1D-0x1F		1	Reserved <sup>(1)</sup>	
0x20	Input MUX register	4	Description shown in subsequent section	0x0001 7772
0x21	Ch 4 source select register	4	Description shown in subsequent section	0x0000 4303
0x22 -0x24		4	Reserved <sup>(1)</sup>	
0x25	PWM MUX register	4	Description shown in subsequent section	0x0102 1345
0x26-0x28		4	Reserved <sup>(1)</sup>	
0x29	ch1_bq[0]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x2A	ch1_bq[1]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000

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SUBADDRESS	REGISTER NAME	NO. OF BYTES	CONTENTS	INITIALIZATION VALUE
0x2B	ch1_bq[2]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x2C	ch1_bq[3]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x2D	ch1_bq[4]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x2E	ch1_bq[5]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x2F	ch1_bq[6]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x30	ch2_bq[0]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x31	ch2_bq[1]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x32	ch2_bq[2]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x33	ch2_bq[3]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000



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### Table 4. Serial Control Interface Register Summary (continued)

SUBADDRESS	REGISTER NAME	NO. OF BYTES	CONTENTS	INITIALIZATION VALUE
0x34	ch2_bq[4]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x35	ch2_bq[5]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x36	ch2_bq[6]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x37 - 0x39		4	Reserved <sup>(2)</sup>	
0x3A	DRC1 ae <sup>(3)</sup>	8	u[31:26], ae[25:0]	0x0080 0000
	DRC1 (1 – ae)	_	u[31:26], (1 – ae)[25:0]	0x0000 0000
0x3B	DRC1 aa	8	u[31:26], aa[25:0]	0x0080 0000
	DRC1 (1 – aa)	_	u[31:26], (1 – aa)[25:0]	0x0000 0000
0x3C	DRC1 ad	8	u[31:26], ad[25:0]	0x0080 0000
	DRC1 (1 – ad)		u[31:26], (1 – ad)[25:0]	0x0000 0000
0x3D	DRC2 ae	8	u[31:26], ae[25:0]	0x0080 0000
	DRC 2 (1 – ae)		u[31:26], (1 – ae)[25:0]	0x0000 0000
0x3E	DRC2 aa	8	u[31:26], aa[25:0]	0x0080 0000
	DRC2 (1 – aa)		u[31:26], (1 – aa)[25:0]	0x0000 0000
0x3F	DRC2 ad	8	u[31:26], ad[25:0]	0x0080 0000
	DRC2 (1 – ad)		u[31:26], (1 – ad)[25:0]	0x0000 0000
0x40	DRC1-T	4	T1[31:0] (9.23 format)	0xFDA2 1490
0x41	DRC1-K	4	u[31:26], K1[25:0]	0x0384 2109
0x42	DRC1-O	4	u[31:26], O1[25:0]	0x0008 4210
0x43	DRC2-T	4	T2[31:0] (9.23 format)	0xFDA2 1490
0x44	DRC2-K	4	u[31:26], K2[25:0]	0x0384 2109
0x45	DRC2-O	4	u[31:26], O2[25:0]	0x0008 4210
0x46	DRC control	4	Description shown in subsequent section	0x0000 0000
0x47–0x4F		4	Reserved <sup>(2)</sup>	
0x50	Bank switch control	4	Description shown in subsequent section	0x0F70 8000
0x51	Ch 1 output mixer	12	Ch 1 output mix1[2]	0x0080 0000
0.01		12	Ch 1 output mix1[1]	0x0000 0000
			Ch 1 output mix1[0]	0x0000 0000
0x52	Ch 2 output mixer	12	Ch 2 output mix[0]	0x0080 0000
0.02		12	Ch 2 output mix2[1]	0x0000 0000
			Ch 2 output mix2[0]	0x0000 0000

(2) Reserved registers should not be accessed.

(3) "ae" stands for  $\alpha$  of energy filter, "aa" stands for  $\alpha$  of attack filter and "ad" stands for  $\alpha$  of decay filter and 1-  $\alpha = \omega$ .

SUBADDRESS	REGISTER NAME	NO. OF BYTES	CONTENTS	INITIALIZATION VALUE
0x53	Ch 1 input mixer	16	Ch 1 input mixer[3]	0x0080 0000
			Ch 1 input mixer[2]	0x0000 0000
			Ch 1 input mixer[1]	0x0000 0000
			Ch 1 input mixer[0]	0x0080 0000
0x54	Ch 2 input mixer	16	Ch 2 input mixer[3]	0x0080 0000
			Ch 2 input mixer[2]	0x0000 0000
			Ch 2 input mixer[1]	0x0000 0000
			Ch 2 input mixer[0]	0x0080 0000
0x55	Channel 3 input mixer	12	Channel 3 input mixer [2]	0x0080 0000
			Channel 3 input mixer [1]	0x0000 0000
			Channel 3 input mixer [0]	0x0000 0000
0x56	Output post-scale	4	u[31:26], post[25:0]	0x0080 0000
0x57	Output pre-scale	4	u[31:26], pre[25:0] (9.17 format)	0x0002 0000
0x58	ch1 BQ[7]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x59	ch1 BQ[8]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x5A	Subchannel BQ[0]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x5B	Subchannel BQ[1]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x5C	ch2 BQ[7]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x5D	ch2 BQ[8]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000

Table 4. Serial Control Interface Register Summary (continued)

0x0000 0000

0x0000 0000

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u[31:26], a1[25:0]

u[31:26], a2[25:0]



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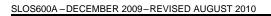
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SUBADDRESS	REGISTER NAME	NO. OF BYTES	CONTENTS	INITIALIZATION VALUE
0x5E	pseudo_ch2 BQ[0]	20	u[31:26], b0[25:0]	0x0080 0000
			u[31:26], b1[25:0]	0x0000 0000
			u[31:26], b2[25:0]	0x0000 0000
			u[31:26], a1[25:0]	0x0000 0000
			u[31:26], a2[25:0]	0x0000 0000
0x5F		4	Reserved <sup>(4)</sup>	
0x60	Channel 4 (subchannel)	8	Ch 4 output mixer[1]	0x0000 0000
	output mixer		Ch 4 output mixer[0]	0x0080 0000
0x61	Channel 4 (subchannel)	8	Ch 4 input mixer[1]	0x0040 0000
	input mixer		Ch 4 input mixer[0]	0x0040 0000
0x62	IDF post scale	4	Post-IDF attenuation register	0x0000 0080
0x63–0xF7			Reserved <sup>(4)</sup>	0x0000 0000
0xF8	Device address enable register	4	Write F9 A5 A5 A5 in this register to enable write to device address update (0xF9)	0x0000 0000
0xF9	Device address Update Register	4	u[31:8], New Dev Id[7:1] , ZERO[0] (New Dev Id (7:1) defines the new device address	0X0000 0036
0xFB-0xFF		4	Reserved <sup>(4)</sup>	0x0000 0000

### Table 4. Serial Control Interface Register Summary (continued)

(4) Reserved registers should not be accessed.

All DAP coefficients are 3.23 format unless specified otherwise.





# CLOCK CONTROL REGISTER (0x00)

The clocks and data rates are automatically determined by the TAS5711. The clock control register contains the auto-detected clock status. Bits D7–D5 reflect the sample rate. Bits D4–D2 reflect the MCLK frequency. The device accepts a 64  $f_S$  or 32  $f_S$  SCLK rate for all MCLK ratios, but accepts a 48  $f_S$  SCLK rate for MCLK ratios of 192  $f_S$  and 384  $f_S$  only.

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	0	-	Ι	-	-	-	$f_S = 32$ -kHz sample rate
0	0	1	-	Ι	-	-	-	Reserved <sup>(1)</sup>
0	1	0	-	1	-	-	-	Reserved <sup>(1)</sup>
0	1	1	-	Ι	-	-	1	$f_S = 44.1/48$ -kHz sample rate <sup>(2)</sup>
1	0	0	-	1	-	-	-	fs = 16-kHz sample rate
1	0	1	-	Ι	-	-	-	fs = 22.05/24 -kHz sample rate
1	1	0	-	Ι	-	-	-	fs = 8-kHz sample rate
1	1	1	-	1	-	-	-	fs = 11.025/12 -kHz sample rate
-	-	-	0	0	0	-	-	MCLK frequency = $64 \times f_{S}^{(3)}$
-	-	-	0	0	1	-	-	MCLK frequency = 128 x $f_{S}^{(3)}$
-	-	-	0	1	0	-	-	MCLK frequency = $192 \times f_S^{(4)}$
-	-	-	0	1	1	-	-	MCLK frequency = 256 × $f_s^{(2)}$ (5)
-	-	-	1	0	0	-	-	MCLK frequency = $384 \times f_S$
-	-	-	1	0	1	-	-	MCLK frequency = $512 \times f_S$
-	-	-	1	1	0	-	-	Reserved <sup>(1)</sup>
-	_	-	1	1	1	-	-	Reserved <sup>(1)</sup>
-	-	-	-	-	I	0	I	Reserved <sup>(1)</sup> <sup>(2)</sup>
_	-	-	-	-	-	-	0	Reserved <sup>(1)</sup> (2)

### Table 5. Clock Control Register (0x00)

(1) Reserved registers should not be accessed.

(2) Default values are in **bold**.

(3) Only available for 44.1 kHz and 48 kHz rates.

(4) Rate only available for 32/44.1/48 KHz sample rates

(5) Not available at 8 kHz

# DEVICE ID REGISTER (0x01)

The device ID register contains the ID code for the firmware revision.

### Table 6. General Status Register (0x01)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	0	0	0	0	0	0	Identification code



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# **ERROR STATUS REGISTER (0x02)**

The error bits are sticky and are not cleared by the hardware. This means that the software must clear the register (write zeroes) and then read them to determine if they are persistent errors.

Error Definitions:

- MCLK Error : MCLK frequency is changing. The number of MCLKs per LRCLK is changing.
- SCLK Error: The number of SCLKs per LRCLK is changing.
- LRCLK Error: LRCLK frequency is changing.
- Frame Slip: LRCLK phase is drifting with respect to internal Frame Sync.

### Table 7. Error Status Register (0x02)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
1	-	-	-	-	-	-	-	MCLK error
-	1	-	-	-	-	-	-	PLL autolock error
-	-	1	-	-	_	_	_	SCLK error
-	-	-	1	-	_	_	_	LRCLK error
_	-	_	_	1	_	_	_	Frame slip
_	-	_	_	_	1	_	_	Clip indicator
_	-	_	_	_	_	1	_	Overcurrent, overtemperature, overvoltage or undervoltage errors
-	-	-	_	-	_	_	0	Reserved
0	0	0	0	0	0	0	_	No errors <sup>(1)</sup>

(1) Default values are in **bold**.

# SYSTEM CONTROL REGISTER 1 (0x03)

The system control register 1 has several functions:

Bit D7: If 0, the dc-blocking filter for each channel is disabled.

If 1, the dc-blocking filter (-3 dB cutoff <1 Hz) for each channel is enabled (default).

Bit D5: If 0, use soft unmute on recovery from clock error. This is a slow recovery. Unmute takes the same time as the volume ramp defined in register 0x0E. If 1, use hard unmute on recovery from clock error (default). This is a fast recovery, a single step

If 1, use hard unmute on recovery from clock error (default). This is a fast recovery, a single step volume ramp

Bits D1–D0: Select de-emphasis

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	-	-	-	-	-	-	-	PWM high-pass (dc blocking) disabled
1	1	-	1	-	-	-	-	PWM high-pass (dc blocking) enabled <sup>(1)</sup>
-	0	-	-	-	-	-	_	Reserved <sup>(1)</sup>
-	-	0	-	-	-	-	_	Soft unmute on recovery from clock error
-	-	1	-	-	-	_	_	Hard unmute on recovery from clock error <sup>(1)</sup>
-	-	_	0	-	-	_	_	Reserved <sup>(1)</sup>
-	-	_	-	0	-	_	_	Reserved <sup>(1)</sup>
-	-	-	-	-	0	-	_	Reserved <sup>(1)</sup>
-	-	-	-	-	-	0	0	No de-emphasis <sup>(1)</sup>
-	1	-	1	-	-	0	1	De-emphasis for $f_S = 32$ kHz
-	-	-	-	-	_	1	0	De-emphasis for $f_S = 44.1 \text{ kHz}$
-	-	-	-	-	-	1	1	De-emphasis for f <sub>S</sub> = 48 kHz

Table 8. System Control Register 1 (0x03)



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# SERIAL DATA INTERFACE REGISTER (0x04)

As shown in Table 9, the TAS5711 supports 9 serial data modes. The default is 24-bit, I<sup>2</sup>S mode,

# Table 9. Serial Data Interface Control Register (0x04) Format

RECEIVE SERIAL DATA INTERFACE FORMAT	WORD LENGTH	D7-D4	D3	D2	D1	D0
Right-justified	16	0000	0	0	0	0
Right-justified	20	0000	0	0	0	1
Right-justified	24	0000	0	0	1	0
l <sup>2</sup> S	16	000	0	0	1	1
l <sup>2</sup> S	20	0000	0	1	0	0
<b>I<sup>2</sup>S</b> <sup>(1)</sup>	24	0000	0	1	0	1
Left-justified	16	0000	0	1	1	0
Left-justified	20	0000	0	1	1	1
Left-justified	24	0000	1	0	0	0
Reserved		0000	1	0	0	1
Reserved		0000	1	0	1	0
Reserved		0000	1	0	1	1
Reserved		0000	1	1	0	0
Reserved		0000	1	1	0	1
Reserved		0000	1	1	1	0
Reserved		0000	1	1	1	1



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# SYSTEM CONTROL REGISTER 2 (0x05)

When bit D6 is set low, the system exits all channel shutdown and starts playing audio; otherwise, the outputs are shut down(hard mute).

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	-	-	-	-	-	-	-	Mid-Z ramp disabled <sup>(1)</sup>
1	-	-	-	-	1	-	-	Mid-Z ramp enabled
-	0	-	1	-	I	-	I	Exit all-channel shutdown (normal operation)
-	1	-	-	-	-	-	-	Enter all-channel shutdown (hard mute) <sup>(1)</sup>
-	-	-	-	0	Ι	-	I	Subchannel in AD mode
-	-	-	-	1	-	-	-	Subchannel in BD mode
-	-	-	-	-	0	-	-	2.0 mode [2.0 BTL] <sup>(1)</sup>
-	-	-	1	-	1	-	I	2.1 mode [2 SE + 1 BTL]
-	0	-	-	-	-	-	-	Exit all-channel shutdown (normal operation)
-	-	-	-	-	Ι	0	I	A_SEL configured as input <sup>(1)</sup>
_	-	-	-	-	_	1	-	A_SEL configured as FAULT output
_	-	0	0	_	-	_	0	Reserved <sup>(1)</sup>

(1) Default values are in **bold**.

### SOFT MUTE REGISTER (0x06)

Writing a 1 to any of the following bits sets the output of the respective channel to 50% duty cycle (soft mute).

### Table 11. Soft Mute Register (0x06)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	0	0	0	-	_	_	Reserved <sup>(1)</sup>
_	_	_	_	-	0	_	-	Soft unmute channel 3 <sup>(1)</sup>
-	-	-	-	-	1	-	-	Soft mute channel 3
-	-	-	-	-	-	0	-	Soft unmute channel 2 <sup>(1)</sup>
-	-	-	-	-	-	1	-	Soft mute channel 2
_	_	_	_	_	-	_	0	Soft unmute channel 1 <sup>(1)</sup>
-	_	_	-	_	-	-	1	Soft mute channel 1

# VOLUME REGISTERS (0x07, 0x08, 0x09, 0x0A)

Step size is 0.5 dB.

Master volume	<ul> <li>– 0x07 (default is mute)</li> </ul>
Channel-1 volume	– 0x08 (default is 0 dB)
Channel-2 volume	– 0x09 (default is 0 dB)
Channel-3 volume	<ul> <li>– 0x0A (default is 0 dB)</li> </ul>

### Table 12. Volume Registers (0x07, 0x08, 0x09, 0x0A)

D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	FUNCTION					
0	0	0	0	0	0	0	0	24 dB					
0	0	1	1	0	0	0	0	0 dB (default for individual channel volume) <sup>(1)</sup>					
	1	1	1	1		1							
1	1	1	1	1	1	1	0	-103 dB					
1	1	1	1	1	1	1	1	Soft mute					

(1) Default values are in **bold**.

# **VOLUME CONFIGURATION REGISTER (0x0E)**

Bits Volume slew rate (Used to control volume change and MUTE ramp rates). These bits control the D2–D0: number of steps in a volume ramp.Volume steps occur at a rate that depends on the sample rate of the I2S data as follows

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Sample Rate (KHz)	Approximate Ramp Rate
8/16/32	125 us/step
11.025/22.05/44.1	90.7 us/step
12/24/48	83.3 us/step

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
1	-	_	1	0	-	_	_	Reserved <sup>(1)</sup>
-	0	-	-	Ι	1	-	1	Subchannel (ch4) volume = ch1 volume <sup>(2)(1)</sup>
-	1	-	-	Ι	-	-	-	Subchannel volume = register 0x0A <sup>(2)</sup>
-	-	0	-	Ι	-	-	-	Ch3 volume = ch2 volume <sup>(1)</sup>
-	-	1	_	-	I	_	I	Ch3 volume = register 0x0A
-	-	-	-	Ι	0	0	0	Volume slew 512 steps (43-ms volume ramp time at 48 kHz)
-	-	-	-	Ι	0	0	1	Volume slew 1024 steps (85-ms volume ramp time at 48 kHz) <sup>(1)</sup>
-	-	_	_	-	0	1	0	Volume slew 2048 steps (171- ms volume ramp time at 48 kHz)
-	-	_	-	-	0	1	1	Volume slew 256 steps (21-ms volume ramp time at 48 kHz)
-	-	_	_	-	1	Х	Х	Reserved

### Table 13. Volume Control Register (0x0E)

(1) Default values are in **bold**.

(2) Bits 6:5 can be changed only when volume is in MUTE [master volume = MUTE (register 0x07 = 0xFF)].

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# **MODULATION LIMIT REGISTER (0x10)**

The modulation limit is the maximum duty cycle of the PWM output waveform.

Table 14. Modulation Limit Register (0x10)										
D7	D6	D5	D4	D3	D2	D1	D0	MODULATION LIMIT		
-	-	_	-	-	0	0	0	99.2%		
_	_	-	-	-	0	0	1	98.4%		
_	_	_	-	-	0	1	0	<b>97.7%</b> <sup>(1)</sup>		
-	-	-	-	-	0	1	1	96.9%		
-	-	-	-	-	1	0	0	96.1%		
_	-	_	-	-	1	0	1	95.3%		
_	-	_	-	-	1	1	0	94.5%		
_	_	-	_	-	1	1	1	93.8%		
0	0	0	0	0	_	_	_	RESERVED		

### Table 14. Modulation Limit Register (0x10)

(1) Default values are in **bold**.

# INTERCHANNEL DELAY REGISTERS (0x11, 0x12, 0x13, and 0x14)

Internal PWM Channels 1, 2,  $\overline{1}$ , and  $\overline{2}$  are mapped into registers 0x11, 0x12, 0x13, and 0x14.

		-	aloro				• · · · · ·		
BITS DEFINITION	D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
	0	0	0	0	0	0	-	-	Minimum absolute delay, 0 DCLK cycles
	0	1	1	1	1	1	-	-	Maximum positive delay, 31 x 4 DCLK cycles
	1	0	0	0	0	0	_	-	Maximum negative delay, -32 x 4 DCLK cycles
							0	0	RESERVED
SUBADDRESS	D7	D6	D5	D4	D3	D2	D1	D0	Delay = (value) × 4 DCLKs
0x11	1	0	1	0	1	1	-	-	Default value for channel 1 <sup>(1)</sup>
0x12	0	1	0	1	0	1	-	-	Default value for channel 2 <sup>(1)</sup>
0x13	1	0	1	0	1	1	-	-	Default value for channel 1 <sup>(1)</sup>
0x14	0	1	0	1	0	1	-	-	Default value for channel 2 (1)

# Table 15. Channel Interchannel Delay Register Format

(1) Default values are in **bold**.

ICD settings have high impact on audio performance (e.g., dynamic range, THD, crosstalk etc.). Therefore, appropriate ICD settings must be used. By default, the device has ICD settings for AD mode. If used in BD mode, then update these registers before coming out of all-channel shutdown.

REGISTER	AD MODE	BD MODE		
0x11	AC	B8		
0x12	54	60		
0x13	AC	A0		
0x14	54	48		

# PWM SHUTDOWN GROUP REGISTER (0x19)

Settings of this register determine which PWM channels are active. The value should be 0x30 for BTL mode and 0x3A for PBTL mode. The default value of this register is 0x30. The functionality of this register is tied to the state of bit D5 in the system control register.

This register defines which channels belong to the shutdown group (SDG). If a 1 is set in the shutdown group register, that particular channel is **not** started following an exit *out of all-channel shutdown* command (if bit D5 is set to 0 in system control register 2, 0x05).

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	-	-	-	_	-	-	-	Reserved <sup>(1)</sup>
_	0	-	-	_	-	-	_	Reserved <sup>(1)</sup>
_	-	1	-	_	-	-	_	Reserved <sup>(1)</sup>
_	-	-	1	_	-	-	-	Reserved <sup>(1)</sup>
-	-	-	-	0	-	-	-	PWM channel 4 does not belong to shutdown group. <sup>(1)</sup>
-	-	-	-	1	-	-	-	PWM channel 4 belongs to shutdown group.
-	-	-	-	_	0	-	-	PWM channel 3 does not belong to shutdown group. <sup>(1)</sup>
-	-	-	-	-	1	-	-	PWM channel 3 belongs to shutdown group.
_	-	-	-	-	_	0	-	PWM channel 2 does not belong to shutdown group. <sup>(1)</sup>
_	-	-	-	-	-	1	-	PWM channel 2 belongs to shutdown group.
-	-	_	_	_	-	-	0	PWM channel 1 does not belong to shutdown group. <sup>(1)</sup>
_	-	_	_	-	-	-	1	PWM channel 1 belongs to shutdown group.

#### Table 16. Shutdown Group Register

(1) Default values are in **bold**.

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# START/STOP PERIOD REGISTER (0x1A)

This register is used to control the soft-start and soft-stop period following an enter/exit all channel shut down command or change in the PDN state. This helps reduce pops and clicks at start-up and shutdown. The times are only approximate and vary depending on device activity level and I2S clock stability.

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	_	Ι	_	_	_	-	I	SSTIMER enabled <sup>(1)</sup>
1	_	Ι	-	_	-	_	I	SSTIMER disabled
-	0	0	-	_	_	_	Ι	Reserved <sup>(1)</sup>
-	_	-	0	0	-	_	-	No 50% duty cycle start/stop period
-	_	I	0	1	0	0	0	16.5-ms 50% duty cycle start/stop period
-	_	-	0	1	0	0	1	23.9-ms 50% duty cycle start/stop period
-	-	Ι	0	1	0	1	0	31.4-ms 50% duty cycle start/stop period
-	-	Ι	0	1	0	1	1	40.4-ms 50% duty cycle start/stop period
-	_	1	0	1	1	0	0	53.9-ms 50% duty cycle start/stop period
-	_	-	0	1	1	0	1	70.3-ms 50% duty cycle start/stop period
-	_	-	0	1	1	1	0	94.2-ms 50% duty cycle start/stop period
-	_	-	0	1	1	1	1	125.7-ms 50% duty cycle start/stop period <sup>(1)</sup>
-	_	-	1	0	0	0	0	164.6-ms 50% duty cycle start/stop period
-	-	-	1	0	0	0	1	239.4-ms 50% duty cycle start/stop period
-	_	-	1	0	0	1	0	314.2-ms 50% duty cycle start/stop period
-	-	-	1	0	0	1	1	403.9-ms 50% duty cycle start/stop period
-	_	1	1	0	1	0	0	538.6-ms 50% duty cycle start/stop period
-	-	-	1	0	1	0	1	703.1-ms 50% duty cycle start/stop period
-	-	-	1	0	1	1	0	942.5-ms 50% duty cycle start/stop period
-	-	-	1	0	1	1	1	1256.6-ms 50% duty cycle start/stop period
-	-	-	1	1	0	0	0	1728.1-ms 50% duty cycle start/stop period
-	-	-	1	1	0	0	1	2513.6-ms 50% duty cycle start/stop period
-	-	-	1	1	0	1	0	3299.1-ms 50% duty cycle start/stop period
-	_	-	1	1	0	1	1	4241.7-ms 50% duty cycle start/stop period
-	-	-	1	1	1	0	0	5655.6-ms 50% duty cycle start/stop period
-	_	-	1	1	1	0	1	7383.7-ms 50% duty cycle start/stop period
-	_	-	1	1	1	1	0	9897.3-ms 50% duty cycle start/stop period
-	-	-	1	1	1	1	1	13,196.4-ms 50% duty cycle start/stop period

### Table 17. Start/Stop Period Register (0x1A)



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### **OSCILLATOR TRIM REGISTER (0x1B)**

The TAS5711 PWM processor contains an internal oscillator to support autodetect of I2S clock rates. This reduces system cost because an external reference is not required. Currently, TI recommends a reference resistor value of 18.2 k $\Omega$  (1%). This should be connected between OSC\_RES and DVSSO.

Writing 0x00 to register 0x1B enables the trim that was programmed at the factory.

Note that trim must always be run following reset of the device.

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
1	-	_	-	-	-	-	_	Reserved <sup>(1)</sup>
-	0	-	Ι	-	-	1	-	Oscillator trim not done (read-only) <sup>(1)</sup>
-	1	-	Ι	-	-	I	-	Oscillator trim done (read only)
-	Ι	0	0	0	0	Ι	-	Reserved <sup>(1)</sup>
-	Ι	-	Ι	-	-	0	-	Select factory trim (Write a 0 to select factory trim; default is 1.)
-	_	_	-	-	-	1	-	Factory trim disabled <sup>(1)</sup>
-	-	_	_	_	-	-	0	Reserved <sup>(1)</sup>

Table 18. Oscillator Trim Register (0x1B)

(1) Default values are in **bold**.

### **BKND\_ERR REGISTER (0x1C)**

When a back-end error signal is received from the internal power stage, the power stage is reset stopping all PWM activity. Subsequently, the modulator waits approximately for the time listed in Table 19 before attempting to re-start the power stage.

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	0	0	0	0	0	Х	Reserved
-	-	-	-	0	0	1	0	Set back-end reset period to 299 ms <sup>(2)</sup>
-	_	_	-	0	0	1	1	Set back-end reset period to 449 ms
-	_	_	-	0	1	0	0	Set back-end reset period to 598 ms
-	-	-	-	0	1	0	1	Set back-end reset period to 748 ms
-	_	_	-	0	1	1	0	Set back-end reset period to 898 ms
-	-	-	-	0	1	1	1	Set back-end reset period to 1047 ms
-	-	_	-	1	0	0	0	Set back-end reset period to 1197 ms
-	-	_	-	1	0	0	1	Set back-end reset period to 1346 ms
-	-	_	-	1	0	1	Х	Set back-end reset period to 1496 ms
-	-	_	-	1	1	Х	Х	Set back-end reset period to 1496 ms

### Table 19. BKND\_ERR Register (0x1C)<sup>(1)</sup>

(1) This register can be written only with a "non-Reserved" value. Also this register can be written once after the reset.



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# INPUT MULTIPLEXER REGISTER (0x20)

This register controls the modulation scheme (AD or BD mode) as well as the routing of I2S audio to the internal channels.

D31	D30	D29	D28	D27	D26	D25	D24	FUNCTION
0	0	0	0	0	0	0	0	Reserved <sup>(1)</sup>
0	U	U	U	U	0	U	U	
D23	D22	D21	D20	D19	D18	D17	D16	FUNCTION
0	_	_	_	-	_	-	-	Channel-1 AD mode <sup>(1)</sup>
1	-	_	-	-	-	-	-	Channel-1 BD mode
-	0	0	0	-	-	-	-	SDIN-L to channel 1 <sup>(1)</sup>
-	0	0	1	-	-	-	-	SDIN-R to channel 1
-	0	1	0	-	-	-	-	Reserved
-	0	1	1	-	-	-	_	Reserved
-	1	0	0	-	-	-	_	Reserved
-	1	0	1	-	-	-	_	Reserved
-	1	1	0	-	-	1	-	Ground (0) to channel 1
-	1	1	1	-	-	1	-	Reserved
_	_	_	_	0	_	I	_	Channel 2 AD mode <sup>(1)</sup>
_	_	_	_	1	_	I	_	Channel 2 BD mode
_	_	_	_	I	0	0	0	SDIN-L to channel 2
-	-	-	-	-	0	0	1	SDIN-R to channel 2 <sup>(1)</sup>
_	_	_	_	I	0	1	0	Reserved
_	_	_	_	I	0	1	1	Reserved
_	_	_	_	I	1	0	0	Reserved
_	_	_	_	I	1	0	1	Reserved
-	-	-	-	-	1	1	0	Ground (0) to channel 2
_	_	_	_	I	1	1	1	Reserved
D15	D14	D13	D12	D11	D10	D9	D8	FUNCTION
0	1	1	1	0	1	1	1	Reserved <sup>(1)</sup>
D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	1	1	1	0	0	1	0	Reserved <sup>(1)</sup>

### Table 20. Input Multiplexer Register (0x20)

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# CHANNEL 4 SOURCE SELECT REGISTER (0x21)

This register selects the channel 4 source.

	I able 21. Subchannel Control Register (0x21)												
D31	D30	D29	D28	D27	D26	D25	D24	FUNCTION					
0	0	0	0	0	0	0	0	Reserved <sup>(1)</sup>					
D23	D22	D21	D20	D19	D18	D17	D16	FUNCTION					
0	0	0	0	0	0	0	0	Reserved <sup>(1)</sup>					
D15	D14	D13	D12	D11	D10	D9	D8	FUNCTION					
0	1	0	0	0	0	1		Reserved <sup>(1)</sup>					
_	_	-	-	_	_	_	0	(L + R)/2					
_	-	-	-	_	-	-	1	Left-channel post-BQ <sup>(1)</sup>					
D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION					
0	0	0	0	0	0	1	1	Reserved <sup>(1)</sup>					

Table 21. Subchannel Control Register (0x21)

(1) Default values are in **bold**.

# **PWM OUTPUT MUX REGISTER (0x25)**

This DAP output mux selects which internal PWM channel is output to the external pins. Any channel can be output to any external output pin.

Bits D21–D20:	Selects which PWM channel is output to OUT_A
Bits D17–D16:	Selects which PWM channel is output to OUT_B
Bits D13–D12:	Selects which PWM channel is output to OUT_C

Bits D09–D08: Selects which PWM channel is output to OUT\_D

Note that channels are encoded so that channel 1 = 0x00, channel 2 = 0x01, ..., channel 4 = 0x03. See Figure 51 for details.

D31	D30	D29	D28	D27	D26	D25	D24	FUNCTION
0	0	0	0	0	0	0	1	Reserved <sup>(1)</sup>
D23	D22	D21	D20	D19	D18	D17	D16	FUNCTION
0	0	-	-	_	-	-	-	Reserved <sup>(1)</sup>
_	-	0	0	-	-	-	_	Multiplex PWM 1 to OUT_A <sup>(1)</sup>
-	-	0	1	-	-	-	-	Multiplex PWM 2 to OUT_A
-	-	1	0	-	-	-	_	Multiplex PWM 3 to OUT_A
-	-	1	1	-	-	-	-	Multiplex PWM 4 to OUT_A
-	-	-	-	0	0	-	-	Reserved <sup>(1)</sup>
-	-	-	-	-	-	0	0	Multiplex PWM 1 to OUT_B
-	-	-	-	-	-	0	1	Multiplex PWM 2 to OUT_B
-	_	-	-	_	-	1	0	Multiplex PWM 3 to OUT_B <sup>(1)</sup>
-	-	-	-	-	-	1	1	Multiplex PWM 4 to OUT_B
D15	D14	D13	D12	D11	D10	D9	D8	FUNCTION
0	0	-	-	-	-	-	-	Reserved <sup>(1)</sup>
-	-	0	0	-	-	-	_	Multiplex PWM 1 to OUT_C
-	-	0	1	-	-	-	_	Multiplex PWM 2 to OUT_C <sup>(1)</sup>

### Table 22. PWM Output Mux Register (0x25)

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-	-	1	0	-	-	-	-	Multiplex PWM 3 to OUT_C				
-	-	1	1	-	-	-	-	Multiplex PWM 4 to OUT_C				
-	_	-	_	0	0	-	-	Reserved <sup>(1)</sup>				
-	-	-	-	-	-	0	0	Multiplex PWM 1 to OUT_D				
-	-	-	-	-	-	0	1	Multiplex PWM 2 to OUT_D				
-	-	-	-	-	-	1	0	Multiplex PWM 3 to OUT_D				
-	_	-	-	-	-	1	1	Multiplex PWM 4 to OUT_D (1)				
		1	1	1	1	1	1					
D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION				
0	1	0	0	0	1	0	1	Reserved <sup>(1)</sup>				

# Table 22. PWM Output Mux Register (0x25) (continued)

# DRC CONTROL (0x46)

Each DRC can be enabled independently using the DRC control register. The DRCs are disabled by default.

D31	D30	D29	D28	D27	D26	D25	D24	FUNCTION
0	0	0	0	0	0	0	0	Reserved <sup>(1)</sup>
D23	D22	D21	D20	D19	D18	D17	D16	FUNCTION
0	0	0	0	0	0	0	0	Reserved <sup>(1)</sup>
D15	D14	D13	D12	D11	D10	D9	D8	FUNCTION
0	0	0	0	0	0	0	0	Reserved <sup>(1)</sup>
D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	_	-	-	-	-	-	Reserved <sup>(1)</sup>
_	-	0	-	_	-	_	_	Disable complementary (1 - H) low-pass filter generation
_	_	1	-	_	_	_	_	Enable complementary (1 - H) low-pass filter generation
_	_	_	0	_	_	_	-	
_	-	-	1	_	-	_	_	
				0	0			Reserved <sup>(1)</sup>
-	-	-	I	-	-	0	-	DRC2 turned OFF <sup>(1)</sup>
_	-	-	-	-	-	1	-	DRC2 turned ON
_	-	-	-	_	_	-	0	DRC1 turned OFF <sup>(1)</sup>
	_	_	-	-	-	-	1	DRC1 turned ON

### Table 23. DRC Control Register



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# BANK SWITCH AND EQ CONTROL (0x50)

Table 24.	Bank	Switching	Command
	Bailly	ownorming	oominana

0         -         -         -         -         -         32 kHz, does not use bank 3         (1)           1         -         -         -         -         -         Reserved(1)           -         -         -         -         Reserved(1)         -         -           -         -         0         -         -         -         Reserved(1)           -         -         0         -         -         -         Reserved(1)           -         -         1         -         -         -         44.148 kHz, uses bank 3         -           -         -         -         1         -         -         16 kHz, uses bank 3         -         -           -         -         -         1         -         -         22.025/24 kHz, uses bank 3         -           -         -         -         -         1         -         22.025/24 kHz, uses bank 3         -           -         -         -         -         1         1.025 kHz/12, does not use bank 3         -           -         -         -         -         -         22.025/24 kHz, uses bank 3         -           1         -<	D31	D30	D29	D28	D27	D26	D25	D24	FUNCTION
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	0	_	_	_	_	_	_	_	32 kHz, does not use bank 3 <sup>(1)</sup>
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	1	_	_	_	_	_	_	_	
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	-	0	_	-	_	_	_	-	Reserved <sup>(1)</sup>
-       -       -       -       -       44.1/48 kHz, uses bank 3         -       -       -       16 kHz, uses bank 3       -         -       -       -       16 kHz, uses bank 3       -         -       -       -       16 kHz, uses bank 3       -         -       -       -       1       -       -       22.025/24 kHz, does not use bank 3         -       -       -       -       1       -       -       22.025/24 kHz, uses bank 3       -         -       -       -       -       -       0       -       8 kHz, uses bank 3       -         -       -       -       -       -       0       1.025 kHz/12, does not use bank 3       -         -       -       -       -       -       0       11.025 kHz/12, does not use bank 3       -         -       -       -       -       -       -       32 kHz, does not use bank 3       -         1       -       -       -       -       -       32 kHz, does not use bank 2       -         1       -       -       -       -       -       Reserved (*)       -       -         -       1	-	-	0	-	-	-	-	-	Reserved <sup>(1)</sup>
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	-	-	_	0	_	_	_	-	44.1/48 kHz, does not use bank 3 <sup>(1)</sup>
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	_	-	_	1	_	_	_	-	44.1/48 kHz, uses bank 3
-       -       -       -       22.025/24 kHz, uses bank 3       ( <sup>1)</sup> -       -       -       1       -       -       22.025/24 kHz, uses bank 3       ( <sup>1)</sup> -       -       -       -       0       -       8 kHz, uses bank 3       ( <sup>1)</sup> -       -       -       -       1       -       8 kHz, uses bank 3       ( <sup>1)</sup> -       -       -       -       -       1       11.025 kHz/12, does not use bank 3       ( <sup>1)</sup> -       -       -       -       -       -       32 kHz, uses bank 3       ( <sup>1)</sup> 0       -       -       -       -       -       32 kHz, uses bank 2       ( <sup>1)</sup> -       1       -       -       -       -       32 kHz, uses bank 2       ( <sup>1)</sup> -       1       -       -       -       -       8 kHz, does not use bank 2       ( <sup>1)</sup> -       1       -       -       -       44.148 kHz, uses bank 2       ( <sup>1)</sup> -       -       1       -       -       -       44.148 kHz, uses bank 2       ( <sup>1)</sup> -       -       1       -       -	_	-	_	_	0	_	_	-	16 kHz, does not use bank 3
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	-	-	-	-	1	-	_	-	16 kHz, uses bank 3 <sup>(1)</sup>
-       -       -       -       0       -       8 kHz, does not use bank 3         -       -       -       -       -       1       -       8 kHz, uses bank 3 ( <sup>1</sup> )         -       -       -       -       -       0       11.025 kHz/12, does not use bank 3         -       -       -       -       -       1       11.025 kHz/12, does not use bank 3 ( <sup>1</sup> )         D23       D22       D21       D20       D19       D18       D17       D16       FUNCTION         0       -       -       -       -       -       32 kHz, does not use bank 2 ( <sup>1</sup> )       1         1       -       -       -       -       -       32 kHz, uses bank 2       1         -       1       -       -       -       -       Reserved ( <sup>1</sup> )       1         -       1       -       -       -       Reserved ( <sup>1</sup> )       1       1       1       1         -       1       -       -       -       44.1/48 kHz, uses bank 2 ( <sup>1</sup> )       1       1       1       1       1       1       1       1       1       1       1       1       1       1       1       1       <	-	-	-	-	_	0	_	-	22.025/24 kHz, does not use bank 3
-         -         -         -         1         -         8 kHz, uses bank 3 <sup>(1)</sup> -         -         -         -         -         -         0         11.025 kHz/12, does not use bank 3 <sup>(1)</sup> D23         D22         D21         D20         D19         D18         D17         D16         FUNCTION           0         -         -         -         -         -         32 kHz, does not use bank 2 <sup>(1)</sup> 1         -         -         -         -         -         32 kHz, does not use bank 2 <sup>(1)</sup> 1         -         -         -         -         -         32 kHz, does not use bank 2 <sup>(1)</sup> -         1         -         -         -         -         Reserved <sup>(1)</sup> -         1         -         -         -         44.1/48 kHz, does not use bank 2 <sup>(1)</sup> -         -         1         -         -         16 kHz, does not use bank 2 <sup>(1)</sup> -         -         1         -         -         16 kHz, does not use bank 2 <sup>(1)</sup> -         -         1         -         2.025/24 kHz, uses bank 2 <sup>(1)</sup> -         -         -         1	-	-	-	-	_	1	_	-	22.025/24 kHz, uses bank 3 <sup>(1)</sup>
-       -       -       -       -       0       11.025 kHz/12, does not use bank 3         -       -       -       -       -       1       11.025/12 kHz, uses bank 3 ( <sup>1</sup> )         D23       D22       D21       D20       D19       D18       D17       D16       FUNCTION         0       -       -       -       -       -       32 kHz, does not use bank 2 ( <sup>1</sup> )         1       -       -       -       -       -       32 kHz, uses bank 2         -       1       -       -       -       -       32 kHz, uses bank 2         -       1       -       -       -       -       32 kHz, uses bank 2         -       1       -       -       -       -       Reserved ( <sup>1</sup> )         -       -       1       -       -       -       Reserved ( <sup>1</sup> )         -       -       1       -       -       -       Reserved ( <sup>1</sup> )         -       -       1       -       -       -       16 kHz, does not use bank 2 ( <sup>1</sup> )         -       -       -       1       1       16 kHz, does not use bank 2 ( <sup>1</sup> )         -       -       -       1 <t< td=""><td>-</td><td>-</td><td>-</td><td>-</td><td>_</td><td>-</td><td>0</td><td>-</td><td>8 kHz, does not use bank 3</td></t<>	-	-	-	-	_	-	0	-	8 kHz, does not use bank 3
-         -         -         -         1         11.025/12 kHz, uses bank 3 ( <sup>1</sup> )           D23         D22         D21         D20         D19         D18         D17         D16         FUNCTION           0         -         -         -         -         -         -         32 kHz, does not use bank 2 ( <sup>1</sup> )           1         -         -         -         -         -         32 kHz, uses bank 2           -         1         -         -         -         -         Reserved ( <sup>1</sup> )           -         -         0         -         -         -         Reserved ( <sup>1</sup> )           -         -         0         -         -         -         Reserved ( <sup>1</sup> )           -         -         1         -         -         44.1/48 kHz, does not use bank 2 ( <sup>1</sup> )           -         -         0         -         -         22.025/24 kHz, does not use bank 2 ( <sup>1</sup> )           -         -         -         1         -         -         22.025/24 kHz, does not use bank 2 ( <sup>1</sup> )           -         -         -         1         -         8 kHz, does not use bank 2 ( <sup>1</sup> )           -         -         -         1         - <td>_</td> <td>_</td> <td>-</td> <td>-</td> <td>_</td> <td>_</td> <td>1</td> <td>-</td> <td>8 kHz, uses bank 3 <sup>(1)</sup></td>	_	_	-	-	_	_	1	-	8 kHz, uses bank 3 <sup>(1)</sup>
D23         D22         D21         D20         D19         D18         D17         D16         FUNCTION           0         -         -         -         -         -         32 kHz, does not use bank 2 <sup>(1)</sup> 1         -         -         -         -         -         32 kHz, uses bank 2           -         1         -         -         -         -         Reserved ( <sup>1</sup> )           -         -         0         -         -         -         Reserved ( <sup>1</sup> )           -         -         0         -         -         -         44.1/48 kHz, does not use bank 2           -         -         1         -         -         -         44.1/48 kHz, does not use bank 2         1           -         -         1         -         -         16 kHz, uses bank 2         1           -         -         -         1         -         -         22.025/24 kHz, uses bank 2         1           -         -         -         -         1         -         8 kHz, uses bank 2         1           -         -         -         -         0         1.025/12 kHz, uses bank 2         1           -	-	-	-	-	_	-	_	0	11.025 kHz/12, does not use bank 3
0       -       -       -       -       -       32 kHz, does not use bank 2 ( <sup>1</sup> )         1       -       -       -       -       -       32 kHz, uses bank 2         -       1       -       -       -       -       32 kHz, uses bank 2         -       1       -       -       -       -       Reserved ( <sup>1</sup> )         -       -       0       -       -       -       Reserved ( <sup>1</sup> )         -       -       0       -       -       -       44.1/48 kHz, does not use bank 2 ( <sup>1</sup> )         -       -       -       1       -       -       -       44.1/48 kHz, uses bank 2 ( <sup>1</sup> )         -       -       -       1       -       -       -       14.1/48 kHz, uses bank 2 ( <sup>1</sup> )         -       -       -       1       -       -       16 kHz, uses bank 2 ( <sup>1</sup> )         -       -       -       1       -       22.025/24 kHz, uses bank 2 ( <sup>1</sup> )         -       -       -       -       1       -       8 kHz, uses bank 2 ( <sup>1</sup> )         -       -       -       -       1       11.025/12 kHz, uses bank 2 ( <sup>1</sup> )         -       -       -       -	_	-	-	-	_	_	_	1	11.025/12 kHz, uses bank 3 <sup>(1)</sup>
1       -       -       -       -       -       32 kHz, uses bank 2         -       1       -       -       -       -       Reserved (1)         -       1       -       -       -       -       Reserved (1)         -       -       0       -       -       -       Reserved (1)         -       -       1       -       -       -       Reserved (1)         -       -       1       -       -       -       Reserved (1)         -       -       1       -       -       -       44.1/48 kHz, does not use bank 2 (1)         -       -       -       0       -       -       16 kHz, does not use bank 2 (1)         -       -       -       0       -       -       22.025/24 kHz, does not use bank 2 (1)         -       -       -       -       0       -       8 kHz, uses bank 2       (1)         -       -       -       -       1       -       8 kHz, does not use bank 2 (1)       (1)         -       -       -       1       1.025/12 kHz, does not use bank 2 (1)       (1)       10         -       -       -       -	D23	D22	D21	D20	D19	D18	D17	D16	FUNCTION
-       1       -       -       -       -       Reserved (1)         -       -       0       -       -       -       Reserved (1)         -       -       0       -       -       -       Reserved (1)         -       -       0       -       -       -       Reserved (1)         -       -       1       -       -       -       44.1/48 kHz, does not use bank 2 (1)         -       -       -       0       -       -       -       16 kHz, does not use bank 2 (1)         -       -       -       0       -       -       22.025/24 kHz, does not use bank 2 (1)         -       -       -       -       0       -       22.025/24 kHz, does not use bank 2 (1)         -       -       -       -       0       -       8 kHz, uses bank 2       1         -       -       -       -       1       -       8 kHz, does not use bank 2 (1)       1         -       -       -       -       1       11.025/12 kHz, does not use bank 2 (1)       1         -       -       -       -       -       32 kHz, does not use bank 1 (1)       1         -	0	I	_	-	_	-	_	-	32 kHz, does not use bank 2 <sup>(1)</sup>
-       -       1       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       -       44.1/48 kHz, does not use bank 2         -       -       1       -       -       -       44.1/48 kHz, uses bank 2 <sup>(1)</sup> -       -       -       0       -       -       -       44.1/48 kHz, uses bank 2 <sup>(1)</sup> -       -       -       0       -       -       -       16 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       1       -       -       -       16 kHz, uses bank 2         -       -       -       0       -       -       22.025/24 kHz, uses bank 2       -         -       -       -       -       -       0       -       8 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       -       0       11.025/12 kHz, uses bank 2         -       -       -       -       -       1       11.025/12 kHz, uses bank 1         1       -       -       -       -       32 kHz, does not use bank 1 <sup>(1)</sup> -       0       -       -       -       32 kHz, uses bank 1 <td< td=""><td>1</td><td>-</td><td>_</td><td>_</td><td>_</td><td>_</td><td>_</td><td>_</td><td>32 kHz, uses bank 2</td></td<>	1	-	_	_	_	_	_	_	32 kHz, uses bank 2
-       -       -       0       -       -       44.1/48 kHz, does not use bank 2         -       -       1       -       -       -       44.1/48 kHz, uses bank 2 (1)         -       -       -       0       -       -       16 kHz, does not use bank 2 (1)         -       -       -       1       -       -       16 kHz, uses bank 2         -       -       -       1       -       -       16 kHz, uses bank 2         -       -       -       1       -       -       16 kHz, uses bank 2         -       -       -       1       -       -       22.025/24 kHz, uses bank 2         -       -       -       -       1       -       22.025/24 kHz, uses bank 2         -       -       -       1       -       8 kHz, uses bank 2       1         -       -       -       1       -       8 kHz, uses bank 2       1         -       -       -       -       0       11.025/12 kHz, uses bank 2       1         -       -       -       -       1       11.025/12 kHz, uses bank 1       1         1       -       -       -       - <t< td=""><td>_</td><td>1</td><td>_</td><td>_</td><td>_</td><td>_</td><td>_</td><td>-</td><td>Reserved <sup>(1)</sup></td></t<>	_	1	_	_	_	_	_	-	Reserved <sup>(1)</sup>
-       -       -       1       -       -       44.1/48 kHz, uses bank 2 <sup>(1)</sup> -       -       -       0       -       -       16 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       1       -       -       16 kHz, uses bank 2         -       -       -       0       -       -       16 kHz, uses bank 2         -       -       -       0       -       22.025/24 kHz, uses bank 2         -       -       -       -       0       -       22.025/24 kHz, uses bank 2         -       -       -       -       0       -       8 kHz, uses bank 2         -       -       -       -       0       -       8 kHz, uses bank 2         -       -       -       -       1       -       8 kHz, uses bank 2         -       -       -       -       -       1       11.025/12 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       -       1       11.025/12 kHz, uses bank 2         0       -       -       -       -       32 kHz, uses bant 1       1         1       -       -       -       32 kHz, does not use bank 1<	_	-	1	_	_	_	_	-	Reserved <sup>(1)</sup>
-       -       -       0       -       -       16 kHz, does not use bank 2 (1)         -       -       -       1       -       -       16 kHz, uses bank 2         -       -       -       0       -       -       22.025/24 kHz, does not use bank 2 (1)         -       -       -       0       -       -       22.025/24 kHz, does not use bank 2 (1)         -       -       -       -       0       -       8 kHz, does not use bank 2 (1)         -       -       -       -       0       -       8 kHz, does not use bank 2 (1)         -       -       -       -       -       0       -       8 kHz, does not use bank 2 (1)         -       -       -       -       -       0       11.025/12 kHz, does not use bank 2 (1)         -       -       -       -       -       1       11.025/12 kHz, does not use bank 1 (1)         -       -       -       -       -       32 kHz, does not use bank 1       1         1       -       -       -       -       32 kHz, uses bank 1       1         -       0       -       -       -       Reserved(1)       1         - <td>_</td> <td>-</td> <td>_</td> <td>0</td> <td>_</td> <td>_</td> <td>_</td> <td>-</td> <td>44.1/48 kHz, does not use bank 2</td>	_	-	_	0	_	_	_	-	44.1/48 kHz, does not use bank 2
-       -       1       -       -       16 kHz, uses bank 2         -       -       -       0       -       -       22.025/24 kHz, does not use bank 2 (1)         -       -       -       1       -       -       22.025/24 kHz, uses bank 2         -       -       -       1       -       22.025/24 kHz, uses bank 2         -       -       -       -       0       -       8 kHz, does not use bank 2 (1)         -       -       -       -       -       1       -       8 kHz, uses bank 2         -       -       -       -       -       1       -       8 kHz, uses bank 2         -       -       -       -       -       0       11.025/12 kHz, uses bank 2         -       -       -       -       -       1       11.025/12 kHz, uses bank 1         -       -       -       -       -       32 kHz, does not use bank 1       1         1       -       -       -       -       32 kHz, uses bank 1       1         -       0       -       -       -       Reserved(1)         -       -       0       -       -       44.1/48 kHz, uses b	-	-	-	1	-	-	-	-	44.1/48 kHz, uses bank 2 <sup>(1)</sup>
-       -       -       0       -       -       22.025/24 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       1       -       -       22.025/24 kHz, uses bank 2         -       -       -       -       0       -       8 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       0       -       8 kHz, uses bank 2         -       -       -       -       1       -       8 kHz, uses bank 2         -       -       -       -       -       0       11.025/12 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       -       1       11.025/12 kHz, uses bank 2         D15       D14       D13       D12       D11       D10       D9       D8       FUNCTION         0       -       -       -       -       -       32 kHz, does not use bank 1       1         -       0       -       -       -       -       Reserved <sup>(1)</sup> -       0       -       -       -       Reserved <sup>(1)</sup> -       -       1       -       -       44.1/48 kHz, uses bank 1         -       -       1 <td>-</td> <td>-</td> <td>-</td> <td>-</td> <td>0</td> <td>-</td> <td>_</td> <td>-</td> <td>16 kHz, does not use bank 2 <sup>(1)</sup></td>	-	-	-	-	0	-	_	-	16 kHz, does not use bank 2 <sup>(1)</sup>
-       -       -       1       -       22.025/24 kHz, uses bank 2         -       -       -       -       0       -       8 kHz, does not use bank 2 ( <sup>1</sup> )         -       -       -       -       1       -       8 kHz, uses bank 2         -       -       -       -       1       -       8 kHz, uses bank 2         -       -       -       -       1       1.025/12 kHz, does not use bank 2 ( <sup>1</sup> )         -       -       -       -       -       1       11.025/12 kHz, uses bank 2         -       -       -       -       -       -       1       11.025/12 kHz, uses bank 2 ( <sup>1</sup> )         -       -       -       -       -       -       1       11.025/12 kHz, uses bank 2 ( <sup>1</sup> )         -       -       -       -       -       -       1       11.025/12 kHz, uses bank 1         1       -       -       -       -       32 kHz, does not use bank 1 ( <sup>1</sup> )         -       -       -       -       -       32 kHz, does not use bank 1 ( <sup>1</sup> )         -       0       -       -       -       Reserved <sup>(1</sup> )         -       -       0       -       -	-	I	-	-	1	-	-	-	16 kHz, uses bank 2
-       -       -       -       0       -       8 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       1       -       8 kHz, uses bank 2         -       -       -       -       -       0       11.025/12 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       -       0       11.025/12 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       -       1       11.025/12 kHz, uses bank 2         D15       D14       D13       D12       D11       D10       D9       D8       FUNCTION         0       -       -       -       -       -       32 kHz, does not use bank 1       1         1       -       -       -       -       -       32 kHz, does not use bank 1 <sup>(1)</sup> -       0       -       -       -       Reserved <sup>(1)</sup> -       0       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       44.1/48 kHz, does not use bank 1 <sup>(1)</sup> -       -       1       -       -       16 kHz, does not use bank 1 <sup>(1)</sup> -       -       1       -<	-	-	-	-	_	0	_	-	22.025/24 kHz, does not use bank 2 <sup>(1)</sup>
- $  -$	-	-	-	-	-	1	-	-	
-       -       -       -       0       11.025/12 kHz, does not use bank 2 <sup>(1)</sup> -       -       -       -       1       11.025/12 kHz, uses bank 2         D15       D14       D13       D12       D11       D10       D9       D8       FUNCTION         0       -       -       -       -       -       32 kHz, does not use bank 1       1         1       -       -       -       -       -       32 kHz, uses bank 1       1         1       -       -       -       -       -       32 kHz, uses bank 1       1         -       0       -       -       -       -       -       32 kHz, uses bank 1 (1)         -       0       -       -       -       -       Reserved <sup>(1)</sup> -       0       -       -       -       Reserved <sup>(1)</sup> -       -       1       -       -       44.1/48 kHz, uses bank 1         -       -       1       -       -       44.1/48 kHz, uses bank 1         -       -       1       -       -       16 kHz, uses bank 1         -       -       1       -       -       22.025/24 kHz, d	_	_	-	-	_	_	0	-	8 kHz, does not use bank 2 <sup>(1)</sup>
-       -       -       -       1       11.025/12 kHz, uses bank 2         D15       D14       D13       D12       D11       D10       D9       D8       FUNCTION         0       -       -       -       -       -       -       32 kHz, does not use bank 1         1       -       -       -       -       -       -       32 kHz, uses bank 1 <sup>(1)</sup> -       0       -       -       -       -       32 kHz, uses bank 1 <sup>(1)</sup> -       0       -       -       -       -       32 kHz, uses bank 1 <sup>(1)</sup> -       0       -       -       -       -       Reserved <sup>(1)</sup> -       0       -       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       44.1/48 kHz, does not use bank 1 <sup>(1)</sup> -       -       0       -       -       16 kHz, uses bank 1         -       -       0       -       22.025/24 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       22.025/24 kHz, uses bank 1	_	-	-	_	_	-	1	_	8 kHz, uses bank 2
D15         D14         D13         D12         D11         D10         D9         D8         FUNCTION           0         -         -         -         -         -         -         32 kHz, does not use bank 1           1         -         -         -         -         -         32 kHz, uses bank 1           -         0         -         -         -         -         32 kHz, uses bank 1           -         0         -         -         -         -         32 kHz, uses bank 1           -         0         -         -         -         -         32 kHz, uses bank 1           -         0         -         -         -         -         32 kHz, uses bank 1           -         0         -         -         -         -         Reserved <sup>(1)</sup> -         -         0         -         -         44.1/48 kHz, does not use bank 1         (1)           -         -         1         -         -         -         16 kHz, uses bank 1         (1)           -         -         -         1         -         -         22.025/24 kHz, does not use bank 1         (1)           - <td< td=""><td>_</td><td>-</td><td>-</td><td>_</td><td>_</td><td>-</td><td>_</td><td>0</td><td>11.025/12 kHz, does not use bank 2 <sup>(1)</sup></td></td<>	_	-	-	_	_	-	_	0	11.025/12 kHz, does not use bank 2 <sup>(1)</sup>
0       -       -       -       -       -       32 kHz, does not use bank 1         1       -       -       -       -       -       32 kHz, uses bank 1 (1)         -       0       -       -       -       -       32 kHz, uses bank 1 (1)         -       0       -       -       -       -       Reserved <sup>(1)</sup> -       0       -       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       -       Reserved <sup>(1)</sup> -       -       1       -       -       44.1/48 kHz, does not use bank 1 <sup>(1)</sup> -       -       0       -       -       16 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       22.025/24 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       22.025/24 kHz, uses bank 1         -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> </td <td>-</td> <td>-</td> <td>-</td> <td>-</td> <td></td> <td></td> <td></td> <td>1</td> <td>11.025/12 kHz, uses bank 2</td>	-	-	-	-				1	11.025/12 kHz, uses bank 2
1       -       -       -       -       32 kHz, uses bank 1 <sup>(1)</sup> -       0       -       -       -       -       Reserved <sup>(1)</sup> -       0       -       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       -       Reserved <sup>(1)</sup> -       -       1       -       -       -       Reserved <sup>(1)</sup> -       -       1       -       -       -       44.1/48 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       0       -       -       16 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       16 kHz, uses bank 1         -       -       -       0       -       -       22.025/24 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup>	D15	D14	D13	D12	D11	D10	D9	D8	FUNCTION
-       0       -       -       -       -       Reserved <sup>(1)</sup> -       0       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       -       44.1/48 kHz, does not use bank 1 <sup>(1)</sup> -       -       1       -       -       -       16 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       16 kHz, uses bank 1         -       -       -       0       -       -       22.025/24 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       22.025/24 kHz, uses bank 1         -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       8 kHz, uses bank 1	0	_	_	_	_	_	_	_	32 kHz, does not use bank 1
-       -       0       -       -       -       Reserved <sup>(1)</sup> -       -       0       -       -       -       44.1/48 kHz, does not use bank 1 <sup>(1)</sup> -       -       1       -       -       -       44.1/48 kHz, uses bank 1         -       -       1       -       -       -       44.1/48 kHz, uses bank 1         -       -       1       -       -       -       44.1/48 kHz, uses bank 1         -       -       1       -       -       -       44.1/48 kHz, uses bank 1         -       -       -       0       -       -       16 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       16 kHz, uses bank 1         -       -       -       0       -       -       22.025/24 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       -       1       -       8 kHz, uses bank 1	1	-	-	-	_	-	_	-	32 kHz, uses bank 1 <sup>(1)</sup>
-       -       -       -       -       44.1/48 kHz, does not use bank 1 <sup>(1)</sup> -       -       1       -       -       -       44.1/48 kHz, uses bank 1         -       -       1       -       -       -       44.1/48 kHz, uses bank 1         -       -       1       -       -       -       16 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       16 kHz, uses bank 1         -       -       -       0       -       -       16 kHz, uses bank 1         -       -       -       0       -       -       16 kHz, uses bank 1         -       -       -       0       -       -       22.025/24 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       22.025/24 kHz, uses bank 1         -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       8 kHz, uses bank 1	-	0	_	-	_	_	_	-	Reserved <sup>(1)</sup>
- $     44.1/48  kHz$ , uses bank 1 $   0$ $  16  kHz$ , does not use bank 1 (1) $   1$ $  16  kHz$ , uses bank 1 $   11$ $  16  kHz$ , uses bank 1 $   0$ $  22.025/24  kHz$ , does not use bank 1 (1) $   1$ $  22.025/24  kHz$ , uses bank 1 $   1$ $  22.025/24  kHz$ , uses bank 1 $    0$ $ 8  kHz$ , does not use bank 1 (1) $    0$ $ 8  kHz$ , does not use bank 1 (1) $     0  black$ $ 8  kHz$ , uses bank 1 (1)	-	-	0	-	_	_	_	-	Reserved <sup>(1)</sup>
- $  -$	-	-	_	0	_	_	_	-	44.1/48 kHz, does not use bank 1 <sup>(1)</sup>
-       -       -       1       -       -       16 kHz, uses bank 1         -       -       -       0       -       -       22.025/24 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       -       22.025/24 kHz, uses bank 1         -       -       -       1       -       -       22.025/24 kHz, uses bank 1         -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       8 kHz, uses bank 1	-	-	-	1	-	-	-	-	44.1/48 kHz, uses bank 1
-       -       -       0       -       -       22.025/24 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       -       1       -       -       22.025/24 kHz, uses bank 1         -       -       -       1       -       -       22.025/24 kHz, uses bank 1         -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       0       -       8 kHz, does not use bank 1 <sup>(1)</sup> -       -       -       1       -       8 kHz, uses bank 1	-	-	-	-	0	-	-	-	16 kHz, does not use bank 1 <sup>(1)</sup>
-         -         -         1         -         -         22.025/24 kHz, uses bank 1           -         -         -         -         -         0         -         8 kHz, does not use bank 1 <sup>(1)</sup> -         -         -         -         1         -         8 kHz, does not use bank 1 <sup>(1)</sup>	-	-	-	-	1	-	-	-	16 kHz, uses bank 1
-         -         -         -         0         -         8 kHz, does not use bank 1 <sup>(1)</sup> -         -         -         -         -         1         -         8 kHz, uses bank 1	-	-	-	-	-	0	-	-	22.025/24 kHz, does not use bank 1 <sup>(1)</sup>
1 _ 8 kHz, uses bank 1	-	-	-	_	-	1	-	-	22.025/24 kHz, uses bank 1
	_	_	_	-	_	_	0	-	8 kHz, does not use bank 1 <sup>(1)</sup>
	_	_	_	_	_	_	1	-	8 kHz, uses bank 1
- $    -$ 0 11.025/12 kHz, does not use bank 1 <sup>(1)</sup>	-	-	-	_	_	-	_	0	11.025/12 kHz, does not use bank 1 <sup>(1)</sup>
11.025/12 kHz, uses bank 1	_	_						1	11.025/12 kHz, uses bank 1

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#### D7 D6 D5 D4 D3 D2 D1 D0 FUNCTION EQ ON 0 EQ OFF (bypass BQ 0-7 of channels 1 and 2) 1 \_ \_ Reserved <sup>(2)</sup> \_ 0 \_ \_ \_ \_ \_ \_ Ignore bank-mapping in bits D31–D8.Use default mapping. (2) \_ \_ 0 \_ \_ \_ \_ Use bank-mapping in bits D31–D8. 1 L and R can be written independently. (2) \_ \_ \_ 0 \_ \_ \_ \_ L and R are ganged for EQ biquads; a write to left-channel BQ is also written to right-channel BQ. (0x29–0x2F is ganged to 0x30–0x36.Also 0x58–0x5B is ganged to 0x5C–0x5F) 1 \_ \_ Reserved <sup>(2)</sup> \_ \_ \_ \_ 0 \_ \_ \_ No bank switching. All updates to DAP (2) 0 0 \_ \_ \_ 0 Configure bank 1 (32 kHz by default) \_ \_ \_ \_ \_ 0 0 1 1 0 Configure bank 2 (44.1/48 kHz by default) 0 \_ \_ \_ \_ \_ \_ \_ \_ \_ \_ 0 1 1 Configure bank 3 (other sample rates by default) \_ \_ \_ \_ 1 0 0 Automatic bank selection \_ \_ \_ \_ 1 0 1 Reserved \_ Х 1 1 Reserved \_ \_ \_ \_ \_

Table 24. Bank Switching Command (continued)

(2) Default values are in **bold**.

# **REVISION HISTORY**

Ch	anges from Original (December 2009) to Revision A	Pag	e
•	Replaced the Dissipations Ratings Table with the Thermal Information Table		8



11-Apr-2013

# **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	•	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
	(1)		Drawing		Qty	(2)		(3)		(4)	
TAS5711PHP	ACTIVE	HTQFP	PHP	48	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	0 to 85	TAS5711	Samples
TAS5711PHPR	ACTIVE	HTQFP	PHP	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	0 to 85	TAS5711	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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# PACKAGE MATERIALS INFORMATION

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# TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TAS5711PHPR	HTQFP	PHP	48	1000	330.0	16.4	9.6	9.6	1.5	12.0	16.0	Q2
TAS5711PHPR	HTQFP	PHP	48	1000	330.0	16.4	9.6	9.6	1.5	12.0	16.0	Q2

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

20-Feb-2014

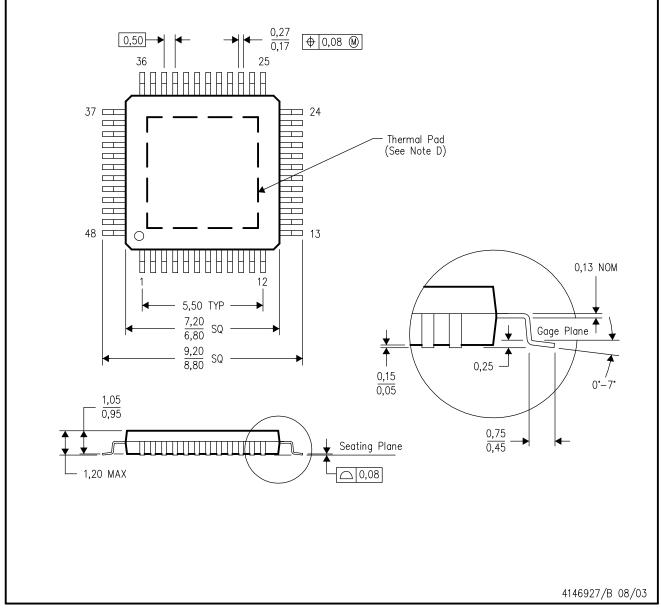


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TAS5711PHPR	HTQFP	PHP	48	1000	336.6	336.6	31.8
TAS5711PHPR	HTQFP	PHP	48	1000	367.0	367.0	38.0

PHP (S-PQFP-G48)

 $\textbf{PowerPAD}^{\,\mathbb{M}} \quad \textbf{PLASTIC} \ \textbf{QUAD} \ \textbf{FLATPACK}$ 



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com <a href="http://www.ti.com">http://www.ti.com</a>.
- E. Falls within JEDEC MS-026

PowerPAD is a trademark of Texas Instruments.



# PHP (S-PQFP-G48)

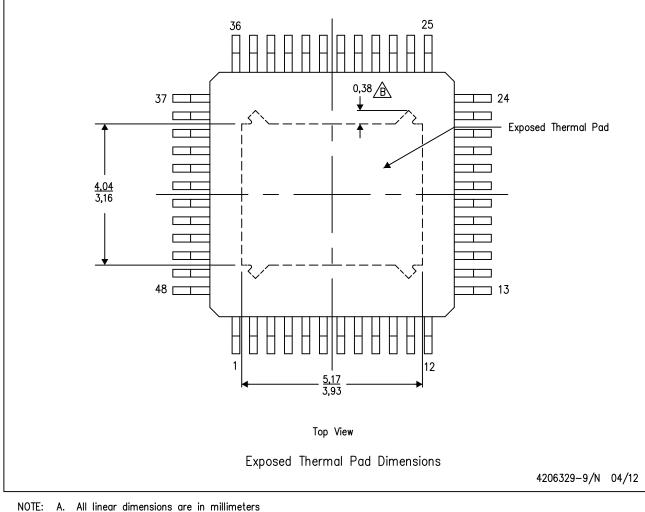
# PowerPAD™ PLASTIC QUAD FLATPACK

# THERMAL INFORMATION

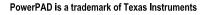
This PowerPAD<sup>™</sup> package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at www.ti.com.

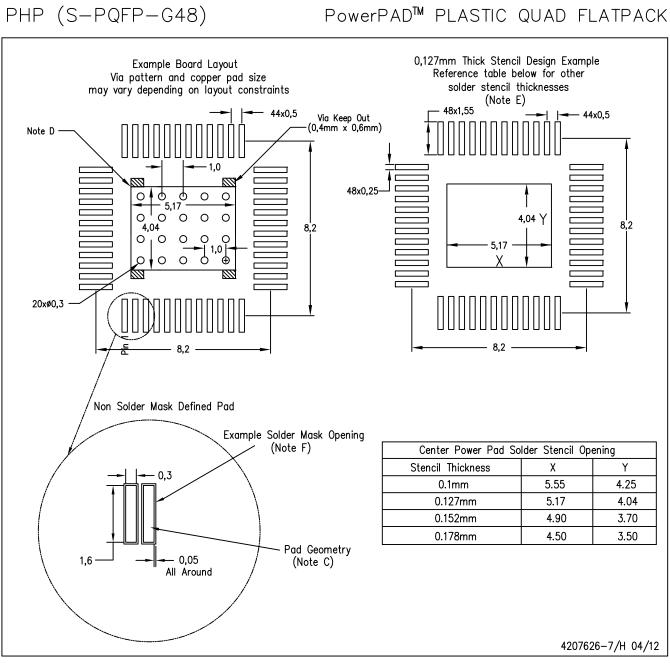
The exposed thermal pad dimensions for this package are shown in the following illustration.



B Tie strap features may not be present.







NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002, SLMA004, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <http://www.ti.com>.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting options for vias placed in the thermal pad.

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